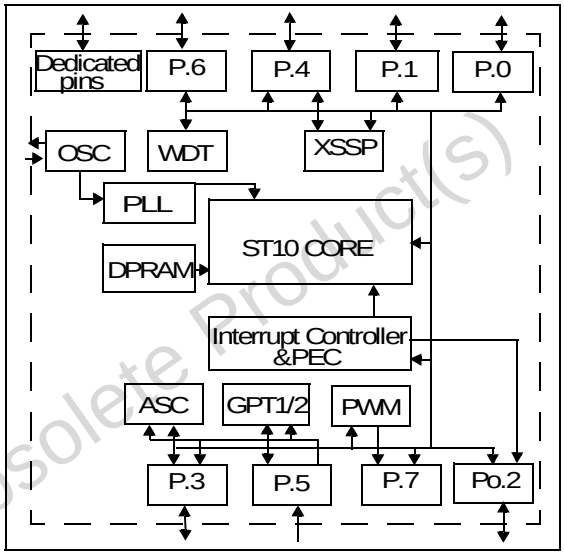
ST10R172L

16-BIT LOW VOLTAGE ROMLESS MCU

DATASHEET

- High Performance 16-bit CPU
  - CPU Frequency: 0 to 50 MHz
  - 40ns instruction cycle time at 50-MHz CPU clock
  - 4-stage pipeline
  - Register-based design with multiple variable register banks
  - Enhanced boolean bit manipulation facilities
  - Additional instructions to support HLL and operating systems
  - Single-cycle context switching support
  - 1024 bytes on-Chip special function register area
- Memory Organisation
  - 1KByte on-chip RAM
  - Up to 16 MBytes linear address space for code and data (1 MByte with SSP used)
- External Memory Interface
  - Programmable external bus characteristics for different address ranges
  - 8-bit or 16-bit external data bus
  - Multiplexed or demultiplexed external address/data buses
  - Five programmable chip-select signals
  - Hold and hold-acknowledge bus arbitration support
- One Channel PWM Unit
- Fail Safe Protection
  - Programmable watchdog timer
  - Oscillator Watchdog
- Interrupt
  - 8-channel interrupt-driven single-cycle data transfer facilities via peripheral event controller (PEC)
  - 16-priority-level interrupt system with 17 sources, sample-rate down to 40 ns
- Timers



  - Two multi-functional general purpose timer units with 5 timers
  - Clock Generation via on-chip PLL, or via direct or prescaled clock input
- Serial Channels
  - Synchronous/asynchronous
  - High-speed-synchronous serial port SSP
- Up to 77 general purpose I/O lines
- No bootstrap loader
- Electrical Characteristics
  - 5V Tolerant I/Os
  - 5V Fail-Safe Inputs (Port 5)
  - Power: 3.3 Volt +/-0.3V
  - Idle and power down modes
- Support
  - C-compilers, macro-assembler packages, emulators, evaluation boards, HLL-debuggers, simulators, logic analyser disassemblers, programming boards
- Package
  - 100-Pin Thin Quad Flat Pack (TQFP)

Rev. 1.2

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1 PIN DESCRIPTION

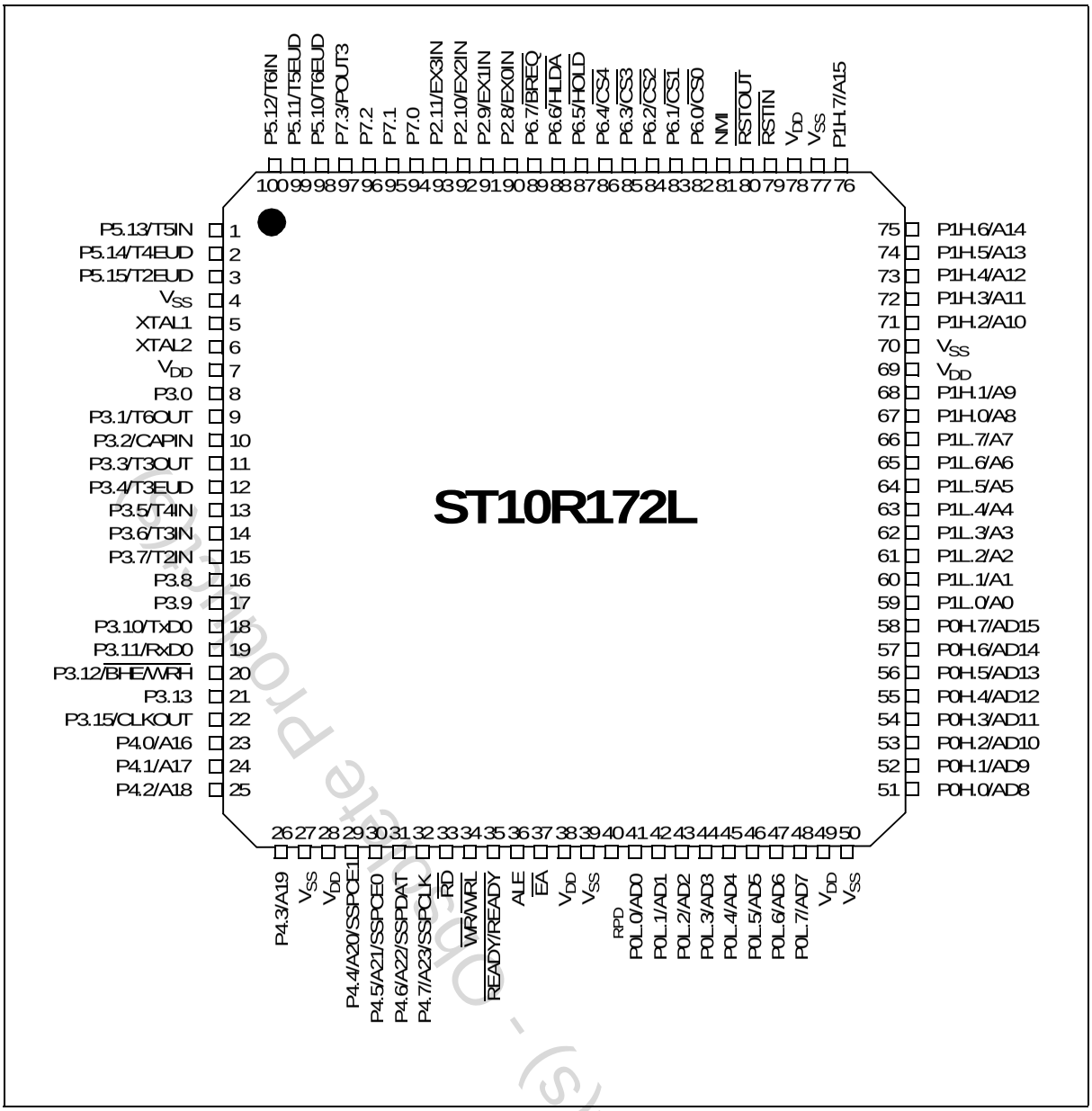


Figure 1 TQFP-100 pin configuration (top view)

Symbol	Pin Number (TQFP)	Input (I) Output (O)	Kind[1)]	Function		
P5.10	98-100	I	5S	6-bit input-only port with Schmitt-Trigger characteristics. Port 5 pins also serve as timer inputs:		
–P5.15	1- 3	I	5S			
	98	I	5S	P5.10	T6EUD	GPT2 Timer T6 Ext.Up/Down Ctrl.Input
	99	I	5S	P5.11	T5EUD	GPT2 Timer T5 Ext.Up/Down Ctrl.Input
	100	I	5S	P5.12	T6IN	GPT2 Timer T6 Count Input
	1	I	5S	P5.13	T5IN	GPT2 Timer T5 Count Input
	2	I	5S	P5.14	T4EUD	GPT1 Timer T4 Ext.Up/Down Ctrl.Input
	3	I	5S	P5.15	T2EUD	GPT1 Timer T2 Ext.Up/Down Ctrl.Input
XTAL1	5	I	3T	XTAL1:	Input to the oscillator amplifier and internal clock generator	
XTAL2	6	O	3T	XTAL2:	Output of the oscillator amplifier circuit. To clock the device from an external source, drive XTAL1, while leaving XTAL2 unconnected. Observe minimum and maximum high/low and rise/fall times specified in the AC Characteristics.	

Table 1 Pin definitions

Symbol	Pin Number (TQFP)	Input (I) Output (O)	Kind[1)]	Function		
P3.0 – P3.13 P3.15	8-21 22	I/O I/O	5T 5T	A 15-bit (P3.14 is missing) bidirectional I/O port. Port 3 is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 3 outputs can be configured as push/ pull or open drain drivers. The following pins have alternate functions:		
	9	O	5T	P3.1	T6OUT	GPT2 Timer T6 toggle latch output
	10	I	5T	P3.2	CAPIN	GPT2 Register CAPREL capture input
	11	O	5T	P3.3	T3OUT	GPT1 Timer T3 toggle latch output
	12	I	5T	P3.4	T3EUD	GPT1 Timer T3 ext.up/down ctrl.input
	13	I	5T	P3.5	T4IN	GPT1 Timer T4 input for count/gate/ reload/capture
	14	I	5T	P3.6	T3IN	GPT1 Timer T3 count/gate input
	15	I	5T	P3.7	T2IN	GPT1 Timer T2 input for count/gate/ reload/capture
	18	O	5T	P3.10	TxD0	ASC0 clock/data output (asyn./syn.)
	19	I/O	5T	P3.11	RxD0	ASC0 data input (asyn.) or I/O (syn.)
	20	O	5T	P3.12	$\overline{BHE}$	Ext. Memory High Byte Enable Signal
		O	5T		$\overline{WRH}$	Ext. Memory High Byte Write Strobe
	22	O	5T	P3.15	CLKOUT	System clock output (=CPU clock)

Table 1 Pin definitions

Symbol	Pin Number (TQFP)	Input (I) Output (O)	Kind[1)]	Function		
P4.0–P4.7	23-26 29-32-	I/O	5T	An 8-bit bidirectional I/O port. Port 8 is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 4 can be used to output the segment address lines for external bus configuration.		
	23	O	5T	P4.0	A16	Least Significant Segment Addr. Line
	...	...	...	...	...	...
	26	O	5T	P4.3	A19	Segment Address Line
	29	O	5T	P4.4	A20	Segment Address Line
		O	5T		SSPCE1	Chip Enable Line 1
	30	O	5T	P4.5	A21	Segment Address Line
		O	5T		SSPCE0	SSPChip Enable Line 0
	31	O	5T	P4.6	A22	Segment Address Line
		I/O	5T		SSPDAT	SSP Data Input/Output Line
	32	O	5T	P4.7	A23	Most Significant Segment Addr. Line
		O	5T		SSPCLK	SSP Clock Output Line
$\overline{RD}$	33	O	5T	External Memory Read Strobe. RD is activated for every external instruction or data read access.		
$\overline{WR}$/ $\overline{WRL}$	34	O	5T	External Memory Write Strobe. In WR-mode, this pin is activated for every external data write access. In WRL-mode, this pin is activated for low byte data write accesses on a 16-bit bus, and for every data write access on an 8-bit bus. See WRCFG in the SYSCON register for mode selection.		
$\overline{READY}$/ $\overline{READY}$	35	I	5T	Ready Input. Active level is programmable. When the Ready function is enabled, the selected inactive level at this pin during an external memory access will force the insertion of memory cycle time waitstates until the pin returns to the selected active level. Polarity is programmable.		

Table 1 Pin definitions

Symbol	Pin Number (TQFP)	Input (I) Output (O)	Kind[1)]	Function
ALE	36	O	5T	Address Latch Enable Output. Can be used for latching the address into external memory or an address latch in the multiplexed bus modes.
$\overline{EA}$	37	I	5T	External Access Enable pin. Low level at this pin during and after reset forces the ST10R172L to begin instruction execution out of external memory. A high level forces execution out of the internal ROM. The ST10R172L must have this pin tied to '0'.
PORT0: P0L.0– P0L.7, P0H.0 - P0H.7	 41 - 48 51 - 58	I/O	5T	PORT0 has two 8-bit bidirectional I/O ports P0L and P0H. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. For external bus configuration, PORT0 acts as address (A) and address/data (AD) bus in multiplexed bus modes and as the data (D) bus in demultiplexed bus modes. **Demultiplexed bus modes** Data Path Width: 8-bit 16-bit P0L.0 – P0L.7: D0 – D7 D0 - D7 P0H.0 – P0H.7: I/O D8 - D15 **Multiplexed bus modes** Data Path Width: 8-bit 16-bit P0L.0 – P0L.7: AD0 – AD7 AD0 - AD7 P0H.0 – P0H.7: A8 – A15 AD8 – AD15
PORT1: P1L.0– P1L.7, P1H.0 - P1H.7	 59- 66 67, 68 71-76	I/O	5T	PORT1 has two 8-bit bidirectional I/O ports P1L and P1H. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. PORT1 acts as a 16-bit address bus (A) in demultiplexed bus modes and also after switching from a demultiplexed bus mode to a multiplexed bus mode.

Table 1 Pin definitions

Symbol	Pin Number (TQFP)	Input (I) Output (O)	Kind[1]	Function		
$\overline{\text{RSTIN}}$	79	I	5T	Reset Input with Schmitt-Trigger characteristics. Resets the device when a low level is applied for a specified duration while the oscillator is running. An internal pullup resistor enables power-on reset using only a capacitor connected to V_{SS}. With a bonding option, the $\overline{\text{RSTIN}}$ pin can also be pulled-down for 512 internal clock cycles for hardware, software or watchdog timer triggered resets		
$\overline{\text{RSTOUT}}$	80	O	5T	Internal Reset Indication Output. This pin is set to a low level when the part is executes hardware-, software- or watchdog timer reset. $\overline{\text{RSTOUT}}$ remains low until the EINIT (end of initialization) instruction is executed.		
$\overline{\text{NMI}}$	81	I	5S	Non-Maskable Interrupt Input. A high to low transition at this pin causes the CPU to vector to the NMI trap routine. If it is not used, $\overline{\text{NMI}}$ should be pulled high externally.		
P6.0-P6.7	82-89	I/O	5T	An 8-bit bidirectional I/O port. Port 6 is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 6 outputs can be configured as push/pull or open drain drivers. The following Port 6 pins have alternate functions:		
	82	O	5T	P6.0	$\overline{\text{CS0}}$	Chip Select 0 Output
	...	...	...	...	...	...
	86	O	5T	P6.4	$\overline{\text{CS4}}$	Chip Select 4 Output
	87	I	5T	P6.5	$\overline{\text{HOLD}}$	External Master Hold Request Input (Master mode: O, Slave mode: I)
	88	I/O	5T	P6.6	$\overline{\text{HLDA}}$	Hold Acknowledge Output
	89	O	5T	P6.7	$\overline{\text{BREQ}}$	Bus Request Output

Table 1 Pin definitions

Symbol	Pin Number (TQFP)	Input (I) Output (O)	Kind[1)]	Function		
P2.8 – P2.11	90 - 93	I/O	5T	Port 2 is a 4-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 2 outputs can be configured as push/pull or open drain drivers. The following Port 2 pins have alternate functions:		
	90	I	5T	P2.8	EX0IN	Fast External Interrupt 0 Input
	...	...	...	...	...	...
	93	I	5T	P2.11	EX3IN	Fast External Interrupt 3 Input
P7.0 – P7.3	94 - 97	I/O	5T	Port 7 is a 4-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 7outputs can be configured as push/pull or open drain drivers. The following Port 7 pins have alternate functions:		
	97	O	5T	P7.3	POUT3	PWM (Channel 3) Output
RPD	40	I/O	5T	Input timing pin for the return from powerdown circuit and power-up asynchronous reset.		
V_{DD}	7, 28, 38, 49, 69, 78	-	PO	Digital supply voltage.		
V_{SS}	4, 27, 39, 50, 70, 77	-	PO	Digital ground.		

Table 1 Pin definitions

1) The following I/O kinds are used. Refer to *ELECTRICAL CHARACTERISTICS* on page 31 for a detailed description.

PO: Power pin

3T: 3 V tolerant pin (voltage max. respect to Vss is -0.5 to VDD + 0.5)

5V: 5 V tolerant pin (voltage max. respect to Vss is -0.5 to 5.5 only if chip is powered)

5S: 5 V tolerant and fail-safe pin (-0.5-5.5 max. voltage w.r.t. Vss even if chip is not powered).

2 FUNCTIONAL DESCRIPTION

ST10R172L architecture combines the advantages of both RISC and CISC processors with an advanced peripheral subsystem. The following block diagram overviews the different on-chip components and the internal bus structure.

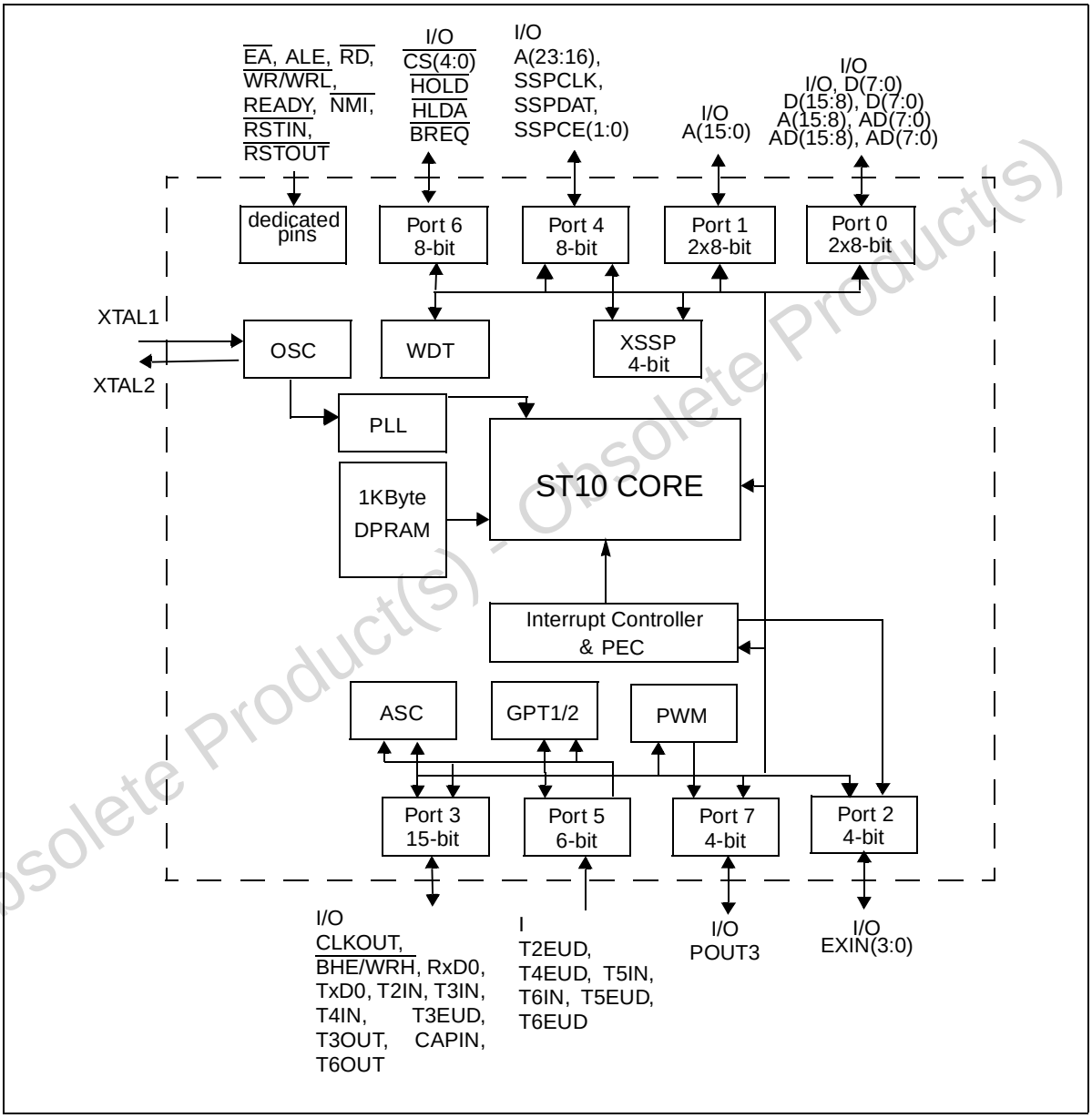


Figure 2 Block diagram

3 MEMORY MAPPING

The ST10R172L is a ROMless device, the internal RAM space is 1 KByte. The RAM address space is used for variables, register banks, the system stack, the PEC pointers (in 00'FCE0h - 00'FCFFh) and the bit-addressable space (in 00'FD00h - 00'FDFFh).

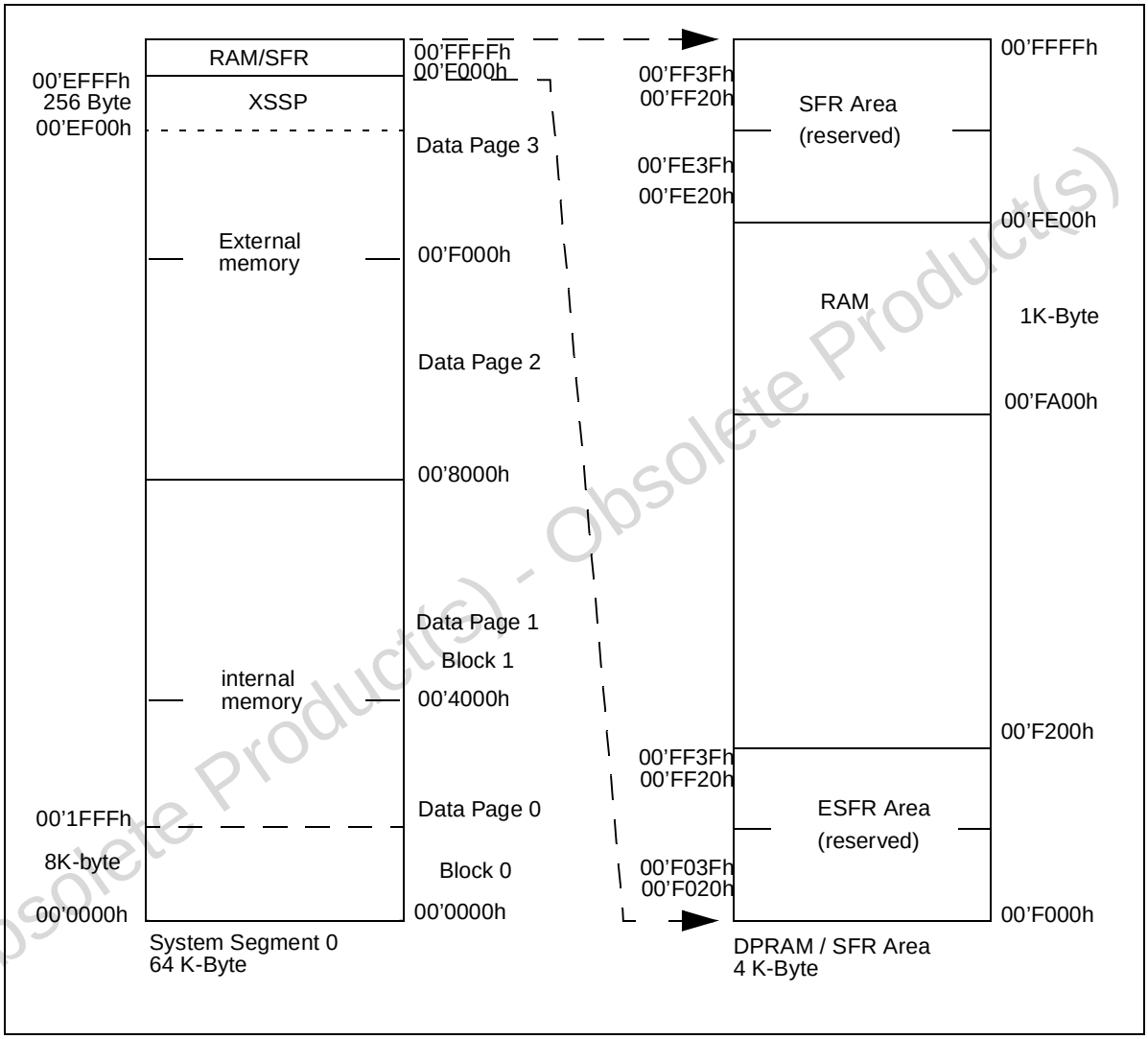


Figure 3 Memory map

4 CENTRAL PROCESSING UNIT

The main core of the CPU contains a 4-stage instruction pipeline, a separate multiply and divide unit, a bit-mask generator and a barrel shifter. Most instructions can be executed in one machine cycle requiring 40ns at 50MHz CPU clock.

The CPU includes an actual register context consisting of 16 wordwide GPRs physically located in the on-chip RAM area. A Context Pointer (CP) register determines the base address of the active register bank to be accessed by the CPU. The number of register banks is only restricted by the available internal RAM space. For easy parameter passing, one register bank may overlap others.

A system stack of up to 1024 bytes is provided as a storage for temporary data. The system stack is allocated in the on-chip RAM area, and it is accessed by the CPU via the stack pointer (SP) register. Two separate SFRs, STKOV and STKUN, are compared against the stack pointer value during each stack access to detect stack overflow or underflow.

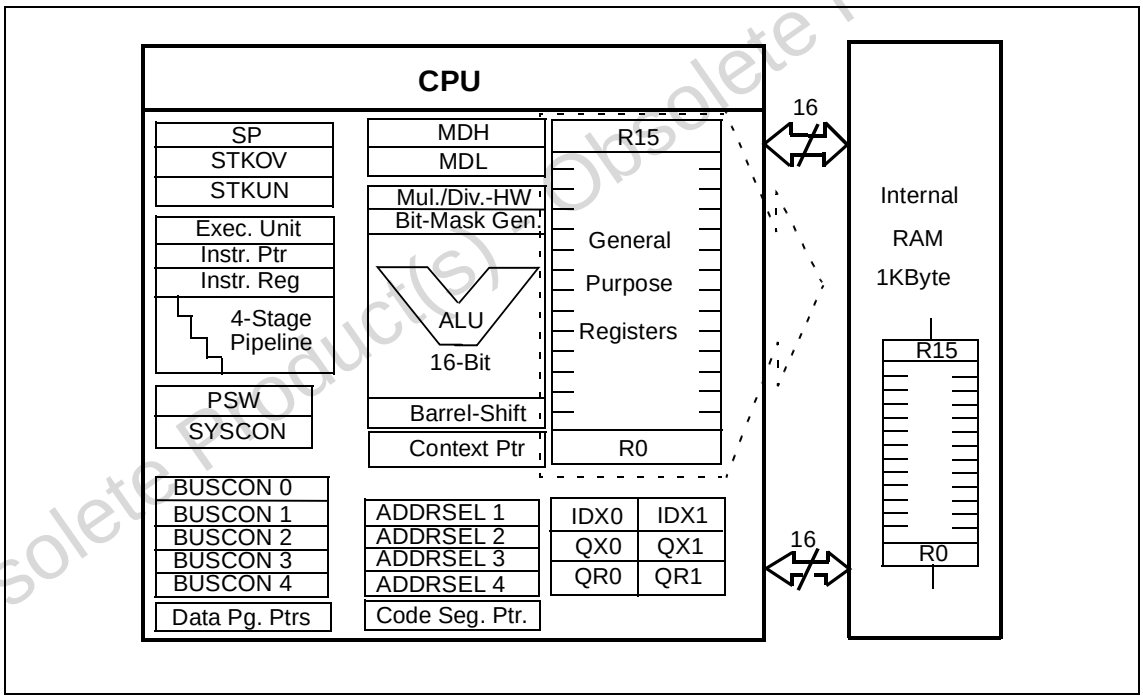


Figure 4 CPU block diagram

5 INTERRUPT AND TRAP FUNCTIONS

The architecture of the ST10R172L supports several mechanisms for fast and flexible response to the service requests that can be generated from various sources, internal or external to the microcontroller. Any of these interrupt requests can be programmed to be serviced, either by the Interrupt Controller or by the Peripheral Event Controller (PEC).

In a standard interrupt service, program execution is suspended and a branch to the interrupt service routine is performed. For a PEC service, just one cycle is ‘stolen’ from the current CPU activity. A PEC service is a single, byte or word data transfer between any two memory locations, with an additional increment of either the PEC source or the destination pointer. An individual PEC transfer counter is decremented for each PEC service, except in the continuous transfer mode. When this counter reaches zero, a standard interrupt is performed to the corresponding source-related vector location. PEC services are very well suited, for example, to the transmission or reception of blocks of data. The ST10R172L has 8 PEC channels, each of which offers fast interrupt-driven data transfer capabilities.

A separate control register which contains an interrupt request flag, an interrupt enable flag and an interrupt priority bitfield, exists for each of the possible interrupt sources. Via its related register, each source can be programmed to one of sixteen interrupt priority levels. Once having been accepted by the CPU, an interrupt service can only be interrupted by a higher priority service request. For standard interrupt processing, each of the possible interrupt sources has a dedicated vector location.

Fast external interrupt inputs are provided to service external interrupts with high precision requirements. These fast interrupt inputs, feature programmable edge detection (rising edge, falling edge or both edges).

Software interrupts are supported by means of the ‘TRAP’ instruction in combination with an individual trap (interrupt) number.

5.1 Interrupt Sources

Source of Interrupt or PEC Service Request	Request Flag	Enable Flag	Interrupt Vector	Vector Location	Trap Number
External Interrupt 0	CC8IR	CC8IE	CC8INT	60h	18h
External Interrupt 1	CC9IR	CC9IE	CC9INT	64h	19h
External Interrupt 2	CC10IR	CC10IE	CC10INT	68h	1Ah
External Interrupt 3	CC11IR	CC11IE	CC11INT	6Ch	1Bh
GPT1 Timer 2	T2IR	T2IE	T2INT	88h	22h
GPT1 Timer 3	T3IR	T3IE	T3INT	8Ch	23h
GPT1 Timer 4	T4IR	T4IE	T4INT	90h	24h
GPT2 Timer 5	T5IR	T5IE	T5INT	94h	25h
GPT2 Timer 6	T6IR	T6IE	T6INT	98h	26h
GPT2 CAPREL Register	CRIR	CRIE	CRINT	9Ch	27h
ASC0 Transmit	S0TIR	S0TIE	S0TINT	A8h	2Ah
ASC0 Transmit Buffer	S0TBIR	S0TBIE	S0TBINT	11Ch	47h
ASC0 Receive	S0RIR	S0RIE	S0RINT	ACh	2Bh
ASC0 Error	S0EIR	S0EIE	S0EINT	B0h	2Ch
PWM Channel 3	PWMIR	PWMIE	PWMINT	FCh	3Fh
SSP Interrupt	XP1IR	XP1IE	XP1INT	104h	41h
PLL Unlock	XP3IR	XP3IE	XP3INT	10Ch	43h

Table 2 List of possible interrupt sources, flags, vector and trap numbers

5.2 Hardware traps

Exceptions or error conditions that arise during run-time are called Hardware Traps. Hardware traps cause immediate non-maskable system reaction similar to a standard interrupt service (branching to a dedicated vector table location). The occurrence of a hardware trap is additionally signified by an individual bit in the trap flag register (TFR). Except when another higher prioritized trap service is in progress, a hardware trap will interrupt any actual program execution. In turn, hardware trap services can not normally be interrupted by standard or PEC interrupts. The following table shows all of the possible exceptions or error conditions that can arise during run-time:

Exception Condition	Trap Flag	Trap Vector	Vector Location	Trap Number	Trap Priority
Reset Functions:					
Hardware Reset		RESET	00'0000h	00h	III
Software Reset		RESET	00'0000h	00h	III
Watchdog Timer Overflow		RESET	00'0000h	00h	III
Class A Hardware Traps:					
Non-Maskable Interrupt	NMI	NMITRAP	00'0008h	02h	II
Stack Overflow	STKOF	STOTRAP	00'0010h	04h	II
Stack Underflow	STKUF	STUTRAP	00'0018h	06h	II
Class B Hardware Traps:					
Undefined opcode	UNDOPC	BTRAP	00'0028h	0Ah	I
Protected instruction fault	PRTFLT	BTRAP	00'0028h	0Ah	I
Illegal word operand access	ILLOPA	BTRAP	00'0028h	0Ah	I
Illegal instruction access	ILLINA	BTRAP	00'0028h	0Ah	I
Illegal external bus access	ILLBUS	BTRAP	00'0028h	0Ah	I
Reserved			[2Ch – 3Ch]	[0Bh – 0Fh]	
Software Traps					
TRAP Instruction			Any [00'0000h – 00'01FCh] steps of 4h	Any [00h – 7Fh]	Current CPU Priority

Table 3 Exceptions or error conditions

6 PARALLEL PORTS

The ST10R172L provides up to 77 I/O lines organized into 7 input/output ports and one input port. All port lines are bit-addressable, and all input/output lines are individually (bit-wise) programmable as inputs or outputs by direction registers. The I/O ports are true bidirectional ports which are switched to high impedance state when configured as inputs. The output drivers of three I/O ports can be configured (pin by pin) for push/pull operation or open-drain operation by control registers. During the internal reset, all port pins are configured as inputs.

All port lines have programmable alternate input or output functions associated with them. PORT0 and PORT1 may be used as address and data lines when accessing external memory, while Port 4 outputs the additional segment address bits A23/19/17...A16 in systems where segmentation is enabled to access more than 64 KBytes of memory. Port 6 provides optional bus arbitration signals ($\overline{BREQ}$, $\overline{HLDA}$, $\overline{HOLD}$) and chip select signals. Port 3 includes alternate functions of timers, serial interfaces, the optional bus control signal $\overline{BHE}$ and the system clock output (CLKOUT). Port 5 is used for timer control signals. Port 2 lines can be used as fast external interrupt lines. Port 7 includes alternate function for the PWM signal. All port lines that are not used for these alternate functions may be used as general purpose I/O lines.

7 EXTERNAL BUS CONTROLLER

All external memory accesses are performed by the on-chip External Bus Controller which can be programmed either to single chip mode when no external memory is required, or to the following external memory access modes:

16-bit data, demultiplexed	16-/18-/20-/24-bit addresses
16-bit data, multiplexed	16-/18-/20-/24-bit addresses
8-bit data, multiplexed	16-/18-/20-/24-bit addresses
8-bit data, demultiplexed	16-/18-/20-/24-bit addresses

In the demultiplexed bus modes, addresses are output on PORT1 and data is input/output on PORT0/P0L, respectively. In the multiplexed bus modes both addresses and data use PORT0 for input/output.

Memory cycle time, memory tri-state time, length of ALE and read write delay are programmable so that a wide range of different memory types and external peripherals can be used. Up to 4 independent address windows can be defined (via ADDRSELx / BUSCONx register pairs) to access different resources with different bus characteristics. These address windows are arranged hierarchically where BUSCON4 overrides BUSCON3 etc. All accesses to locations not covered by these 4 address windows are controlled by BUSCON0. Up to 5 external $\overline{CS}$ signals (4 windows plus default) can be generated to reduce external glue logic. Access to very slow memories is supported by the READY function.

A $\overline{HOLD}$/$\overline{HLDA}$ protocol is available for bus arbitration so that external resources can be shared with other bus masters. In slave mode, the slave controller can be connected to another master controller without glue logic. For applications which require less than 16 MBytes

of external memory space, the address space can be restricted to 1 MByte, 256 KByte or to 64 KByte.

8 PWM MODULE

A 1-channel Pulse Width Modulation (PWM) Module operates on channel 3. The pulse width modulation module can generate up to four PWM output signals using edge-aligned or centre-aligned PWM. In addition, the PWM module can generate PWM burst signals and single shot outputs. The table below shows the PWM frequencies for different resolutions. The level of the output signals is selectable and the PWM module can generate interrupt requests.

Mode 0 edge aligned	**Resolution**	**8-bit**	**10-bit**	**12-bit**	**14-bit**	**16-bit**
CPU clock/1	20ns	195.3 KHz	48.83KHz	12.21KHz	3.052KHz	762.9Hz
CPU clock/64	1.28ns	3.052KHz	762.9Hz	190.7Hz	47.68Hz	11.92Hz
Mode 1 center aligned	**Resolution**	**8-bit**	**10-bit**	**12-bit**	**14-bit**	**16-bit**
CPU clock/1	20ns	97.66KHz	24.41KHz	6.104KHz	1.525KHz	381.5Hz
CPU clock/64	1.28ns	1.525Hz	381.5 Hz	95.37Hz	23.84Hz	0Hz

Table 4 PWM unit frequencies and resolution at 50MHz CPU clock

9 GENERAL PURPOSE TIMERS

The GPTs are flexible multifunctional timer/counters used for time-related tasks such as event timing and counting, pulse width and duty cycle measurements, pulse generation or pulse multiplication. The GPT unit contains five 16-bit timers, organized in two separate modules, GPT1 and GPT2. Each timer in each module may operate independently in a number of different modes, or may be concatenated with another timer of the same module.

9.1 GPT1

Each of the three timers T2, T3, T4 of the GPT1 module can be configured individually for one of four basic modes of operation: **timer**, **gated timer**, **counter mode and incremental interface mode**. In timer mode, the input clock for a timer is derived from the CPU clock, divided by a programmable prescaler. In counter mode, the timer is clocked in reference to external events. Pulse width or duty cycle measurement is supported in gated timer mode where the operation of a timer is controlled by the 'gate' level on an external input pin. For these purposes, each timer has one associated port pin (TxIN) which serves as gate or clock input. Table 5 GPT1 timer input frequencies, resolution and periods lists the timer input frequencies, resolution and periods for each pre-scaler option at 50MHz CPU clock. This also applies to the Gated Timer Mode of T3 and to the auxiliary timers T2 and T4 in Timer and Gated Timer Mode

The count direction (up/down) for each timer is programmable by software or may additionally be altered dynamically by an external signal on a port pin (TxEUD).

In Incremental Interface Mode, the GPT1 timers (T2, T3, T4) can be directly connected to the incremental position sensor signals A and B by their respective inputs TxIN and TxEUD. Direction and count signals are internally derived from these two input signals so that the contents of the respective timer Tx corresponds to the sensor position. The third position sensor signal TOP0 can be connected to an interrupt input.

Timer T3 has output toggle latches (TxOTL) which changes state on each timer over-flow/ underflow. The state of this latch may be output on port pins (TxOUT) e. g. for time out monitoring of external hardware components, or may be used internally to clock timers T2 and T4 for measuring long time periods with high resolution.

In addition to their basic operating modes, timers T2 and T4 may be configured as reload or capture registers for timer T3. When used as capture or reload registers, timers T2 and T4 are stopped. The contents of timer T3 is captured into T2 or T4 in response to a signal at their associated input pins (TxIN). Timer T3 is reloaded with the contents of T2 or T4 triggered either by an external signal or by a selectable state transition of its toggle latch T3OTL. When both T2 and T4 are configured to alternately reload T3 on opposite state transitions of T3OTL with the low and high times of a PWM signal, this signal can be constantly generated without software intervention.

F_{CPU}=50MHz	Timer input selection							
	000b	**001b**	**010b**	**011b**	**100b**	**101b**	**110b**	**111b**
Prescaler Factor	8	16	32	64	128	256	512	1024
Input Frequency	6.25 MHz	3.125 MHz	1.5625 MHz	781 KHz	391 KHz	195 KHz	97.5 KHz	48.83 KHz
Resolution	160ns	320ns	640ns	1.28 us	2.56 us	5.12 us	10.24 us	20.48 us
Period	10.49ms	20.97ms	41.94ms	83.88ms	168ms	336ms	672ms	1.342s

Table 5 GPT1 timer input frequencies, resolution and periods

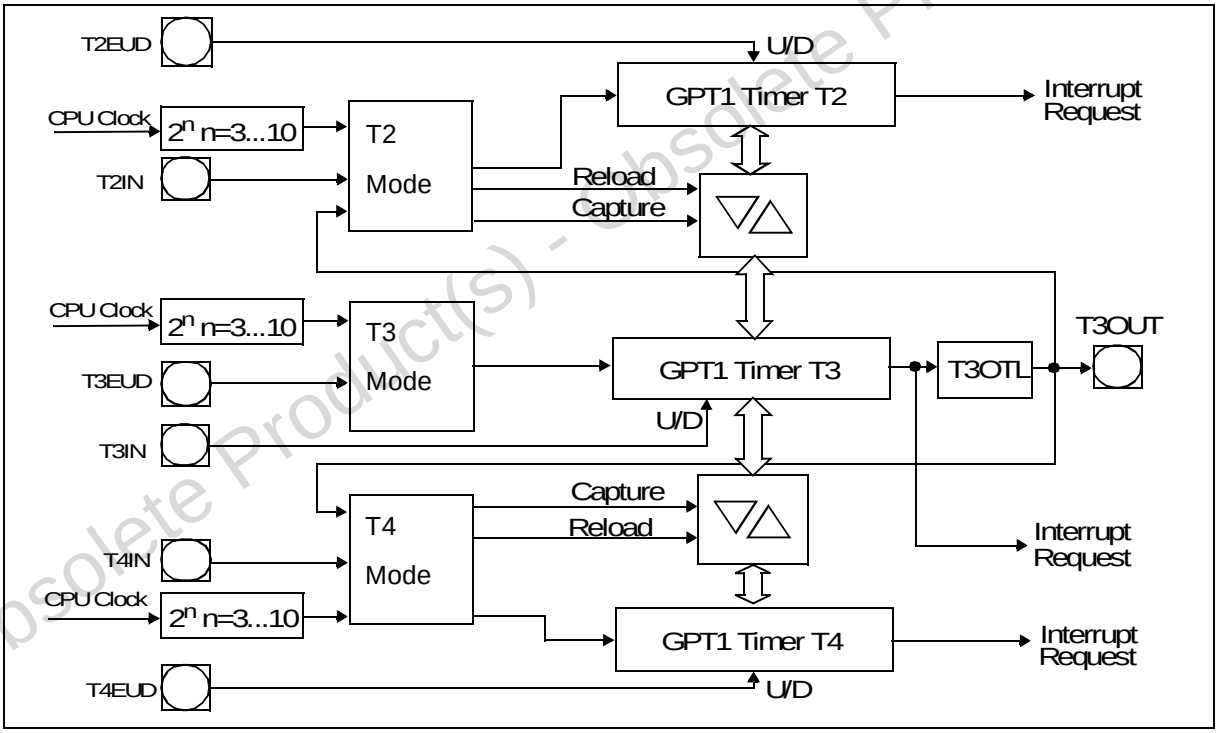


Figure 5 GPT1 block diagram

9.2 GPT2

The GPT2 module provides precise event control and time measurement. It includes two timers (T5, T6) and a capture/reload register (CAPREL). Both timers can be clocked with an input clock derived from the CPU clock via a programmable prescaler or with external signals. The count direction (up/down) for each timer is programmable by software or altered dynamically by an external signal on a port pin (TxEUD). Concatenation of the timers is supported by the output toggle latch (T6OTL) of timer T6, which changes its state on each timer overflow/underflow.

The state of T6OTL may be used to clock timer T5, or may be output on a port pin T6OUT. The overflows/underflows of timer T6 reload the CAPREL register. The CAPREL register captures the contents of T5 based on an external signal transition on the corresponding port pin (CAPIN), and timer T5 may optionally be cleared after the capture procedure. This allows absolute time differences to be measured or pulse multiplication to be performedwithout software overhead.

F_{CPU}=50MHz	**Timer input selection**							
	000b	**001b**	**010b**	**011b**	**100b**	**101b**	**110b**	**111b**
Prescaler Factor	4	8	16	32	64	128	256	512
Input Frequency	12.5 MHz	6.25 MHz	3.125 MHz	1.563 MHz	781 KHz	391 KHz	195 KHz	97.6 KHz
Resolution	80ns	160ns	320ns	640ns	1.28 us	2.56 us	5.12 us	10.24 us
Period	5.24ms	10.49ms	20.97ms	41.94ms	83.88ms	167.7ms	335.5ms	671ms

Table 6 GPT2 timer input frequencies, resolution and periods

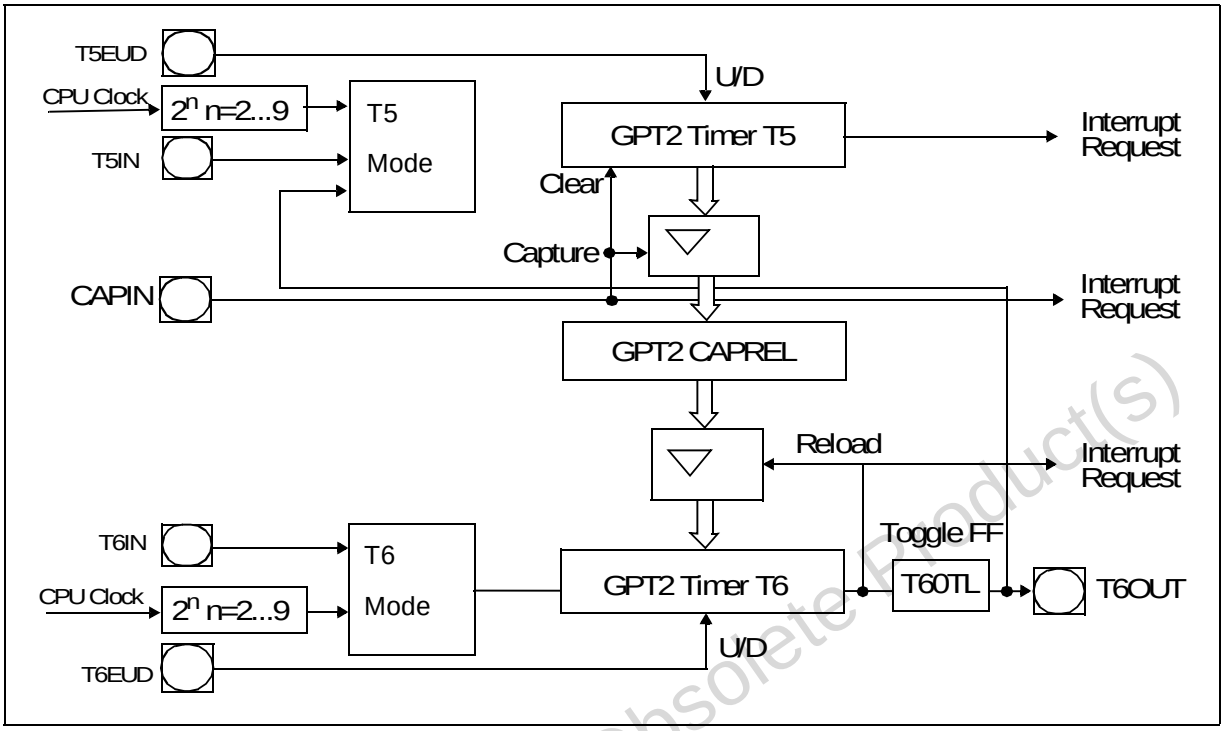


Figure 6 GPT2 block diagram

10 SERIAL CHANNELS

Serial communication with other microcontrollers, processors, terminals or external peripheral components is provided by two serial interfaces with different functionality, an Asynchronous/ Synchronous Serial Channel (ASC0) and a Synchronous Serial Port (SSP).

ASC0

A dedicated baud rate generator sets up standard baud rates without oscillator tuning. 3 separate interrupt vectors are provided for transmission, reception, and erroneous reception. In asynchronous mode, 8- or 9-bit data frames are transmitted or received, preceded by a start bit and terminated by one or two stop bits. For multiprocessor communication, a mechanism to distinguish address from data bytes has been included (8-bit data + wake up bit mode).

In synchronous mode, the ASC0 transmits or receives bytes (8 bits) synchronously to a shift clock which is generated by the ASC0. The ASC0 always shifts the LSB first. A loop back option is available for testing purposes.

A number of optional hardware error detection capabilities have been included to increase the reliability of data transfers. A parity bit can be generated automatically on transmission, or checked on reception. Framing error detection recognizes data frames with missing stop bits. An overrun error is generated if the last character received was not read out of the receive buffer register at the time the reception of a new character is complete.The table below lists

various commonly used baud rates together with the required reload values and the deviation errors compared to the intended baudrate.

S0BRS = '0', f_{CPU} = 50MHz				S0BRS = '1', f_{CPU} = 50MHz			
Baud Rate (Baud)	**Deviation Error**		**Reload Value**	**Baud Rate (Baud)**	**Deviation Error**		**Reload Value**
1562500	0.0%	/ 0.0%	0000_H / 0000_H	1041666	0.0%	/ 0.0%	0000_H / 0000_H
56000	+3.3%	/ -0.4%	$001A_H$ / $001B_H$	56000	+3.3%	/ -2.1%	0011_H / 0012_H
38400	+1.7%	/ -0.8%	0027_H / 0028_H	38400	+0.5%	/ -3.1%	$001A_H$ / $001B_H$
19200	+0.5%	/ -0.8%	0050_H / 0051_H	19200	+0.5%	/-1.4%	0035_H / 0036_H
9600	+0.5%	/ -0.1%	$00A1_H$/ $00A2_H$	9600	+0.5%	/ -0.5%	$006B_H$ / $006C_H$
4800	+0.2%	/ -0.1%	0144_H / 0145_H	4800	0.0%	/ -0.5%	$00D8_H$ / $00D9_H$
2400	0.0%	/ -0.1%	$028A_H$ / $028B_H$	2400	0.0%	/ -0.2%	$01B1_H$ / $01B2_H$
1200	0.0%	/ -0.1%	0515_H / 0516_H	1200	0.0%	/ -0.1%	0363_H / 0364_H
600	0.0%	/ 0.0%	$0A2B_H$ / $0A2C_H$	600	0.0%	/ -0.1%	$06C7_H$ / $06C8_H$
190	+0.4%	/+0.4%	$1FFF_H$ / $1FFF_H$	75	0.0%	/ 0.0%	$363F_H$ / 3640_H
				127	+0.1%	/ +0.1%	$1FFF_H$ / $1FFF_H$

Table 7 Commonly used baud rates, required reload values and deviation errors

SSP transmits 1...3 bytes or receives 1 byte after sending 1...3 bytes synchronously to a shift clock which is generated by the SSP. The SSP can start shifting with the LSB or with the MSB and is used to select shifting and latching clock edges, and clock polarity. Up to two chip select lines may be activated in order to direct data transfers to one or both of two peripheral devices.

When the SSP is enabled, the four upper pins of Port4 can not be used as general purpose IO. Note that the segment address selection done via the system start-up configuration during reset has priority and overrides the SSP functions on these pins.

SSPCKS Value		Synchronous baud rate
000	SSP clock = CPU clock divided by 2	25 MBit/s
001	SSP clock = CPU clock divided by 4	12.5 MBit/s
010	SSP clock = CPU clock divided by 8	6.25 MBit/s

Table 8 Synchronous baud rate and SSPCKS reload values

SSPCKS Value		Synchronous baud rate
011	SSP clock = CPU clock divided by 16	3.13 MBit/s
100	SSP clock = CPU clock divided by 32	1.56 MBit/s
101	SSP clock = CPU clock divided by 64	781 KBit/s
110	SSP clock = CPU clock divided by 128	391 KBit/s
111	SSP clock = CPU clock divided by 256	195 KBit/s

Table 8 Synchronous baud rate and SSPCKS reload values

11 WATCHDOG TIMER

The Watchdog Timer is a fail-safe mechanism which limits the malfunction time of the controller. The Watchdog Timer is always enabled after device reset and can only be disabled in the time interval until the EINIT (end of initialization) instruction has been executed. In this way, the chip's start-up procedure is always monitored. The software must be designed to service the Watchdog Timer before it overflows. If, due to hardware or software related failures, the software fails to maintain the Watchdog Timer, it will overflow generating an internal hardware reset and pulling the $\overline{\text{RSTOUT}}$ pin low to reset external hardware components.

The Watchdog Timer is a 16-bit timer, clocked with the system clock divided either by 2 or by 128. The high byte of the Watchdog Timer register can be set to a pre-specified reload value (stored in WDTREL) in order to allow further variation of the monitored time interval. Each time it is serviced by the application software, the high byte of the Watchdog Timer is reloaded. The table below shows the watchdog time range which for a 50MHz CPU clock rounded to 3 significant figures.

Reload value in WDTREL	Prescaler for f_{CPU}	
	2 (WDTIN = '0')	128 (WDTIN = '1')
FF_H	10.24 µs	655 µs
00_H	2.62 ms	168 ms

Table 9 Watchdog timer range

12 SYSTEM RESET

The following type of reset are implemented on the ST10R172L:

Asynchronous hardware reset: Asynchronous reset does not require a stabilized clock signal on XTAL1 as it is not internally resynchronized, it resets the microcontroller into its default reset state. Asynchronous reset is required on chip power-up and can be used during catastrophic situations. The rising edge of the RSTIN pin is internally resynchronized before exiting the reset condition, therefore, only the entry to hardware reset is asynchronous.

Synchronous hardware reset (warm reset): A warm synchronous hardware reset is triggered when the reset input signal $\overline{\text{RSTIN}}$ is latched low and Vpp pin is high. The I/Os are immediately (asynchronously) set in high impedance, $\overline{\text{RSTOUT}}$ is driven low. After $\overline{\text{RSTIN}}$ negation is detected, a short transition period elapses, during which pending internal hold states are cancelled and any current internal access cycles are completed, external bus cycles are aborted. Then, the internal reset sequence is active for 1024 TCL (512 CPU clock cycles). During this reset sequence, if bit BDRSTEN was previously set by software (bit 3 in SYSCON register), $\overline{\text{RSTIN}}$ pin is driven low and internal reset signal is asserted to reset the microcontroller in its default state. Note that after all reset sequence, bit BDRSTEN is cleared. After the reset sequence has been completed, the $\overline{\text{RSTIN}}$ input is sampled. When the reset input signal is active at that time the internal reset condition is prolonged until $\overline{\text{RSTIN}}$ becomes inactive.

Software reset: The reset sequence can be triggered at any time by the protected instruction SRST (software reset). This instruction can be executed deliberately within a program, e.g. to leave bootstrap loader mode, or on a hardware trap that reveals a system failure. As for a synchronous hardware reset, if bit BDRSTEN was previously set by software (bit 3 in SYSCON register), the reset sequence lasts 1024 TCL (512 CPU clock cycles), and drives the $\overline{\text{RSTIN}}$ pin low.

Watchdog timer reset: When the watchdog timer is not disabled during the initialization or serviced regularly during program execution it will overflow and trigger the reset sequence. Unlike hardware and software resets, the watchdog reset completes a running external bus cycle if this bus cycle does not use $\overline{\text{READY}}$, or if $\overline{\text{READY}}$ is sampled active (low) after the programmed waitstates. When $\overline{\text{READY}}$ is sampled inactive (high) after the programmed waitstates the running external bus cycle is aborted. Then the internal reset sequence is started. The watchdog reset cannot occur while the ST10R172L is in bootstrap loader mode.

Bidirectional reset: The bidirectional reset is activated by setting bit BDRSTEN (bit 3 in SYSCON register). This reset makes the watchdog timer reset and software reset externally visible. It is active for the duration of an internal reset sequences caused by a watchdog timer reset and software reset. Therefore, the bidirectional reset transforms an internal watchdog timer reset or software reset into an external hardware reset with a minimum duration of 1024 TCL.

13 POWER REDUCTION MODES

Two different power reduction modes with different levels of power reduction can be entered under software control.

In **Idle mode** the CPU is stopped, while the peripherals continue their operation. Idle mode can be terminated by any reset or interrupt request.

In **Power Down mode** both the CPU and the peripherals are stopped. Power Down mode can now be configured by software in order to be terminated only by a hardware reset or by an external interrupt source on fast external interrupt pins.

All external bus actions are completed before Idle or Power Down mode is entered. However, Idle or Power Down mode is **not** entered if READY is enabled, but has not been activated (driven low for negative polarity, or driven high for positive polarity) during the last bus access.

14 SPECIAL FUNCTION REGISTERS

The following table lists all ST10R172L SFRs in alphabetical order.
Bit-addressable SFRs are marked with the letter “b” in column “Name”. SFRs within the Extended SFR-Space (ESFRs) are marked with the letter “E” in column “Physical Address”.

An SFR can be specified by its individual mnemonic name. Depending on the selected addressing mode, an SFR can be accessed by its physical address (using the Data Page Pointers), or by its short 8-bit address (without using the Data Page Pointers).

Name	Physical Address	8-Bit Address	Description	Reset Value
ADDRSEL1	FE18h	0Ch	Address Select Register 1	0000h
ADDRSEL2	FE1Ah	0Dh	Address Select Register 2	0000h
ADDRSEL3	FE1Ch	0Eh	Address Select Register 3	0000h
ADDRSEL4	FE1Eh	0Fh	Address Select Register 4	0000h
BUSCON0 b	FF0Ch	86h	Bus Configuration Register 0	0XX0h
BUSCON1 b	FF14h	8Ah	Bus Configuration Register 1	0000h
BUSCON2 b	FF16h	8Bh	Bus Configuration Register 2	0000h
BUSCON3 b	FF18h	8Ch	Bus Configuration Register 3	0000h
BUSCON4 b	FF1Ah	8Dh	Bus Configuration Register 4	0000h
CAPREL	FE4Ah	25h	GPT2 Capture/Reload Register	0000h
CC8IC b	FF88h	C4h	EX0IN Interrupt Control Register	0000h

Table 10 Special functional registers

Name		Physical Address		8-Bit Address	Description	Reset Value
CC9IC	b	FF8Ah		C5h	EX1IN Interrupt Control Register	0000h
CC10IC	b	FF8Ch		C6h	EX2IN Interrupt Control Register	0000h
CC11IC	b	FF8Eh		C7h	EX3IN Interrupt Control Register	0000h
CP		FE10h		08h	CPU Context Pointer Register	FC00h
CRIC	b	FF6Ah		B5h	GPT2 CAPREL Interrupt Control Register	0000h
CSP		FE08h		04h	CPU Code Segment Pointer Register (read only)	0000h
DP0L	b	F100h	E	80h	P0L Direction Control Register	00h
DP0H	b	F102h	E	81h	P0h Direction Control Register	00h
DP1L	b	F104h	E	82h	P1L Direction Control Register	00h
DP1H	b	F106h	E	83h	P1h Direction Control Register	00h
DP2	b	FFC2h		E1h	Port 2 Direction Control Register	-0--h
DP3	b	FFC6h		E3h	Port 3 Direction Control Register	0000h
DP4	b	FFCAh		E5h	Port 4 Direction Control Register	00h
DP6	b	FFCEh		E7h	Port 6 Direction Control Register	00h
DP7	b	FFD2h		E9h	Port 7 Direction Control Register	-0h
DPP0		FE00h		00h	CPU Data Page Pointer 0 Register (10 bits)	0000h
DPP1		FE02h		01h	CPU Data Page Pointer 1 Register (10 bits)	0001h
DPP2		FE04h		02h	CPU Data Page Pointer 2 Register (10 bits)	0002h
DPP3		FE06h		03h	CPU Data Page Pointer 3 Register (10 bits)	0003h
EBUSCON	b	F10Eh	E	87H	Extended BUSCON register	0000h
EXICON	b	F1C0h	E	E0h	External Interrupt Control Register	0000h
IDCHIP		F07Ch	E	3Eh	Device Identifier Register	1101h
IDMANUF		F07Eh	E	3Fh	Manufacturer/Process Identifier Register	0201h
IDMEM		F07Ah	E	3Dh	On-chip Memory Identifier Register	0000h
IDPROG		F078h	E	3Ch	Programming Voltage Identifier Register	0000h
MDC	b	FF0Eh		87h	CPU Multiply Divide Control Register	0000h

Table 10 Special functional registers

Name	Physical Address	8-Bit Address	Description	Reset Value
MDH	FE0Ch	06h	CPU Multiply Divide Register – High Word	0000h
MDL	FE0Eh	07h	CPU Multiply Divide Register – Low Word	0000h
ODP2 b	F1C2h E	E1h	Port 2 Open Drain Control Register	-0--h
ODP3 b	F1C6h E	E3h	Port 3 Open Drain Control Register	0000h
ODP6 b	F1CEh E	E7h	Port 6 Open Drain Control Register	00h
ODP7 b	F1D2h E	E9h	Port 7 Open Drain Control Register	-0h
ONES	FF1Eh	8Fh	Constant Value 1's Register (read only)	FFFFh
P0L b	FF00h	80h	Port 0 Low Register (Lower half of PORT0)	00h
P0H b	FF02h	81h	Port 0 High Register (Upper half of PORT0)	00h
P1L b	FF04h	82h	Port 1 Low Register (Lower half of PORT1)	00h
P1H b	FF06h	83h	Port 1 High Register (Upper half of PORT1)	00h
P2 b	FFC0h	E0h	Port 2 Register (4 bits)	-0--h
P3 b	FFC4h	E2h	Port 3 Register	0000h
P4 b	FFC8h	E4h	Port 4 Register (8 bits)	00h
P5 b	FFA2h	D1h	Port 5 Register (read only)	XXXXh
P6 b	FFCCh	E6h	Port 6 Register (8 bits)	00h
P7 b	FFD0h	E8h	Port 7Register (4 bits)	-0h
PECC0	FEC0h	60h	PEC Channel 0 Control Register	0000h
PECC1	FEC2h	61h	PEC Channel 1 Control Register	0000h
PECC2	FEC4h	62h	PEC Channel 2 Control Register	0000h
PECC3	FEC6h	63h	PEC Channel 3 Control Register	0000h
PECC4	FEC8h	64h	PEC Channel 4 Control Register	0000h
PECC5	FECAh	65h	PEC Channel 5 Control Register	0000h
PECC6	FECCh	66h	PEC Channel 6 Control Register	0000h
PECC7	FECEh	67h	PEC Channel 7 Control Register	0000h
PP3	F03Eh E	1Fh	PWM Module Period Register 3	0000h

Table 10 Special functional registers

Name	Physical Address	8-Bit Address	Description	Reset Value
PSW b	FF10h	88h	CPU Program Status Word	0000h
PW3	FE36h	1Bh	PWM Module Pulse Width Register 3	0000h
PWMCON0 b	FF30h	98h	PWM Module Control Register 0	0000h
PWMCON1 b	FF32h	99h	PWM Module Control Register 1	0000h
PWMIC b	F17Eh E	BFh	PWM Module Interrupt Control Register	0000h
RP0H b	F108h E	84h	System Start-up Configuration Register (Rd. only)	XXh
S0BG	FEB4h	5Ah	Serial Channel 0 baud rate generator reload reg	0000h
S0CON b	FFB0h	D8h	Serial Channel 0 Control Register	0000h
S0EIC b	FF70h	B8h	Serial Channel 0 Error Interrupt Control Register	0000h
S0RBUF	FEB2h	59h	Serial Channel 0 receive buffer reg. (rd only)	XXh
S0RIC b	FF6Eh	B7h	Serial Channel 0 Receive Interrupt Control Reg.	0000h
S0TBIC b	F19Ch E	CEh	Serial Channel 0 transmit buffer interrupt control reg	0000h
S0TBUF	FEB0h	58h	Serial Channel 0 transmit buffer register (wr only)	00h
S0TIC b	FF6Ch	B6h	Serial Channel 0 Transmit Interrupt Control Register	0000h
SP	FE12h	09h	CPU System Stack Pointer Register	FC00h
SSPCON0	EF00h X	---	SSP Control Register 0	0000h
SSPCON1	EF02h X	---	SSP Control Register 1	0000h
SSPRTB	EF04h X	---	SSP Receive/Transmit Buffer	XXXXh
SSPTBH	EF06h X	---	SSP Transmit Buffer High	XXXXh
STKOV	FE14h	0Ah	CPU Stack Overflow Pointer Register	FA00h
STKUN	FE16h	0Bh	CPU Stack Underflow Pointer Register	FC00h
SYSCON b	FF12h	89h	CPU System Configuration Register	0xx0h[1)]
T2	FE40h	20h	GPT1 Timer 2 Register	0000h
T2CON b	FF40h	A0h	GPT1 Timer 2 Control Register	0000h
T2IC b	FF60h	B0h	GPT1 Timer 2 Interrupt Control Register	0000h

Table 10 Special functional registers

Name	Physical Address	8-Bit Address	Description	Reset Value
T3	FE42h	21h	GPT1 Timer 3 Register	0000h
T3CON b	FF42h	A1h	GPT1 Timer 3 Control Register	0000h
T3IC b	FF62h	B1h	GPT1 Timer 3 Interrupt Control Register	0000h
T4	FE44h	22h	GPT1 Timer 4 Register	0000h
T4CON b	FF44h	A2h	GPT1 Timer 4 Control Register	0000h
T4IC b	FF64h	B2h	GPT1 Timer 4 Interrupt Control Register	0000h
T5	FE46h	23h	GPT2 Timer 5 Register	0000h
T5CON b	FF46h	A3h	GPT2 Timer 5 Control Register	0000h
T5IC b	FF66h	B3h	GPT2 Timer 5 Interrupt Control Register	0000h
T6	FE48h	24h	GPT2 Timer 6 Register	0000h
T6CON b	FF48h	A4h	GPT2 Timer 6 Control Register	0000h
T6IC b	FF68h	B4h	GPT2 Timer 6 Interrupt Control Register	0000h
TFR b	FFACh	D6h	Trap Flag Register	0000h
WDT	FEAEh	57h	Watchdog Timer Register (read only)	0000h
WDTCON	FFAEh	D7h	Watchdog Timer Control Register	000xh[2)]
XP1IC b	F18Eh E	C7h	SSP Interrupt Control Register	0000h
XP3IC b	F19Eh E	CFh	PLL unlock Interrupt Control Register	0000h
ZEROS b	FF1Ch	8Eh	Constant Value 0's Register (read only)	0000h

Table 10 Special functional registers

Note 1. The system configuration is selected during reset.

Note 2. Bit WDTR indicates a watchdog timer triggered reset.

15 ELECTRICAL CHARACTERISTICS

15.1 Absolute Maximum Ratings

- Ambient temperature under bias (T_A): .....-40°C to +85 °C
- Storage temperature (T_{ST}): ..... – 65 to +150 °C
- Voltage on V_{DD} pins with respect to ground (V_{SS}): ..... – 0.5 to +4.0 V
- Voltage on any pin with respect to ground (V_{SS}): ..... –0.5 to V_{DD} +0.5 V
- Voltage on any 5V tolerant pin with respect to ground (V_{SS}): .....–0.5 to 5.5 V
- Voltage on any 5V fail-safe pin with respect to ground (V_{SS}): .....–0.5 to 5.5 V
- Input current on any pin during overload condition: .....–10 to +10 mA
- Absolute sum of all input currents during overload condition: .....|100 mA|
- Power dissipation:.....1.0 W

Note *Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not guaranteed. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. During overload conditions (V_{IN}>V_{DD} or V_{IN}<V_{SS}) the voltage on pins with respect to ground (V_{SS}) must not exceed the values defined by the Absolute Maximum Ratings.*

The parameters listed in this section represent both the ST10R172L controller characteristics and the system requirements. To aid parameters interpretation in design evaluation, the a symbol column is marked:

CC for **C**ontroller **C**haracteristics:	The ST10R172L logic provides signals with the respective timing characteristics.
SR for System Requirement:	The external system must provide signals with the respective timing characteristics to the ST10R172L.

Remarks on 5 volt tolerant (5T) and 5 volt fail-safe (5S) pins

The 5V tolerant input and output pins can sustain an absolute maximum external voltage of 5.5V.

However, signals on unterminated bus lines might have overshoot above 5.5V, presenting latchup and hot carrier risks. While these risks are under evaluation, observe the following security recommendations:

- Maximum peak voltage on 5V tolerant pin with respect to ground (V_{SS})= +6 V
- If the ringing of the external signal exceeds 6V, then clip the signal to the 5V supply.

Power supply failure condition

The power supply failure condition is a state where the chip is NOT supplied but is connected to active signal lines. There are several cases:

- 3.3V external lines on 3.3V (3T) pin on the non powered chip: ..... NOT Acceptable
- 3.3V external lines on 5V tolerant (5T) pin on the non powered chip: ..... Acceptable

  The 5V tolerant buffer do not leak: external signals not altered. No reliability problem.
- 3.3V external lines on 5V fail-safe (5S) pin on the non powered chip: ..... Acceptable

  The 5V tolerant buffer do not leak: external signals not altered. No reliability problem.
- 5.5V external lines on 5V tolerant (5T) pin on the non powered chip: ..... Acceptable

  For VERY SHORT times only: the buffers do not leak (external signals not altered) but there is a fast degradation of the gate oxides in the buffers. The total maximum time under this stress condition is 2 days. This limits this configuration to short power-up/down sequences. For 10 year life time, the maximum duty factor is 1/1800 allowing e.g. a maximum stress duration of 48 seconds per day.
- 5.5V external lines on 5V fail-safe (5S) pin on the non powered chip: ..... Acceptable
- 6V transient signals on 5V tolerant (5T) pin on the non powered chip: ... NOT Acceptable
- 6V transient signals on 5V fail-safe (5S) pin on the non powered chip:..... Acceptable

15.2 DC Characteristics

V_{DD} = 3.3V ± 0.3V V_{SS} = 0 V Reset active T_A = -40°C to +85 °C°

Parameter	Symbol		Limit Values		Unit	Test Condition
			min.	max.		
Input low voltage	V_{IL}	SR	– 0.3	0.8	V	–
Input high voltage (all except $\overline{RSTIN}$ and XTAL1)	V_{IH}	SR	2.0	V_{DD} + 0.3	V	–
Input high voltage $\overline{RSTIN}$, RPD	V_{IH1}	SR	0.6 V_{DD}	V_{DD} + 0.3	V	–
Input high voltage XTAL1	V_{IH2}	SR	0.7 V_{DD}	V_{DD} + 0.3	V	–
Output low voltage (ALE, $\overline{RD}$, $\overline{WR}$, $\overline{BHE}$, CLKOUT, $\overline{RSTIN}$,$\overline{RSTOUT}$, $\overline{CSX}$)	V_{OL}	CC	–	0.4	V	I_{OL} = 4 mA
Output low voltage (all other outputs)	V_{OL1}	CC	–	0.4	V	I_{OL1} = 2 mA
Output high voltage ALE, $\overline{RD}$, $\overline{WR}$, $\overline{BHE}$, CLKOUT, $\overline{RSTIN}$,$\overline{RSTOUT}$, $\overline{CSX}$)	V_{OH}	CC	2.4	–	V	I_{OH} = –4 mA
Output high voltage[1] (all other outputs)	V_{OH1}	CC	2.4	–	V	I_{OH} = – 2mA
Input leakage current (3T pins)	I_{OZ}	CC	–	±10	µA	0 V<V_{IN}<V_{DD}
Input leakage current (5T, 5S pins)	I_{OZ1}	CC	–	±10 ±100[7]	µA µA	0 V<V_{IN}<V_{DD} V_{DD}<V_{IN}<5.0V[7]
$\overline{RSTIN}$ pull-up resistor [2]	R_{RST}	CC	20	300	kΩ	V_{IN} = 0 V
Read/Write pullup current[3]	I_{RWH} [4]		–	-40	µA	V_{OUT} = 2.4 V
Read/Write pullup current[3]	I_{RWL} [5]		-500	–	µA	V_{OUT} = 0.4 V
ALE pulldown current[3]	I_{ALEL} [4]		40	–	µA	V_{OUT} = 0.4 V
ALE pulldown current[3]	I_{ALEH} [5]		–	500	µA	V_{OUT} = 2.4 V
Port 6 ($\overline{CS}$) pullup current[3]	I_{P6H} [4]		–	-40	µA	V_{OUT} = 2.4 V
Port 6 ($\overline{CS}$) pullup current[3]	I_{P6L} [5]		-500	–	µA	V_{OUT} = 0.4 V

Table 11 DC characteristics

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
PORT0 configuration current[3]	I_{P0H}[4]	–	-4	µA	$V_{IN} = V_{IHmin}$
	I_{P0L}[5]	-50	–	µA	$V_{IN} = V_{ILmax}$
RPD pulldown current[2]	I_{RPD}[5]	100	500	µA	$V_{OUT} = V_{DD}$
XTAL1 input current	I_{IL} CC	–	±20	µA	$0\ V < V_{IN} < V_{DD}$
Pin capacitance[6)] (digital inputs/outputs)	C_{IO} CC	–	10	pF	f = 1 MHz T_A = 25 °C
Power supply current	I_{CC}	–	15 + 2.5 * f_{CPU}	mA	f_{CPU} in [MHz] [7)]
Idle mode supply current	I_{ID}	–	10 + 0.9 * f_{CPU}	mA	$\overline{RSTIN} = V_{IH1}$ f_{CPU} in [MHz] [7]
Power-down mode supply current	I_{PD} [8]	–	200	µA	V_{DD} = 3.6 V [9]

Table 11 DC characteristics

1) This specification is not valid for outputs which are switched to open drain mode. In this case the respective output will float and the resulting voltage comes from the external circuitry.
2) This specification is only valid during reset, or interruptible power-down mode, after reception of an external interrupt signal that will wake up the CPU.
3) This specification is only valid during reset, hold or adapt-mode. Port 6 pins are only affected if they are used for $\overline{CS}$ output and the open drain function is not enabled.
4) The maximum current may be drawn while the signal line remains inactive.
5) The minimum current must be drawn in order to drive the signal line active.
6) Not 100% tested, guaranteed by design characterization.
7) Supply current is a function of operating frequency as illustrated in Figure 7 on page 35. This parameter is tested at V_{DD}max and 50 MHz CPU clock with all outputs disconnected and all inputs at V_{IL} or V_{IH} with an infinite execution of NOP instruction fetched from external memory (16-bit demux bus mode, no waitstates, no memory tri-state waitstates, normal ALE).
8) Typical value at 25°C = 20µA.
9) This parameter is tested including leakage currents. All inputs (including pins configured as inputs) at 0 V to 0.1 V or at V_{DD} – 0.1 V to V_{DD}, V_{REF} = 0 V, all outputs (including pins configured as outputs) disconnected.

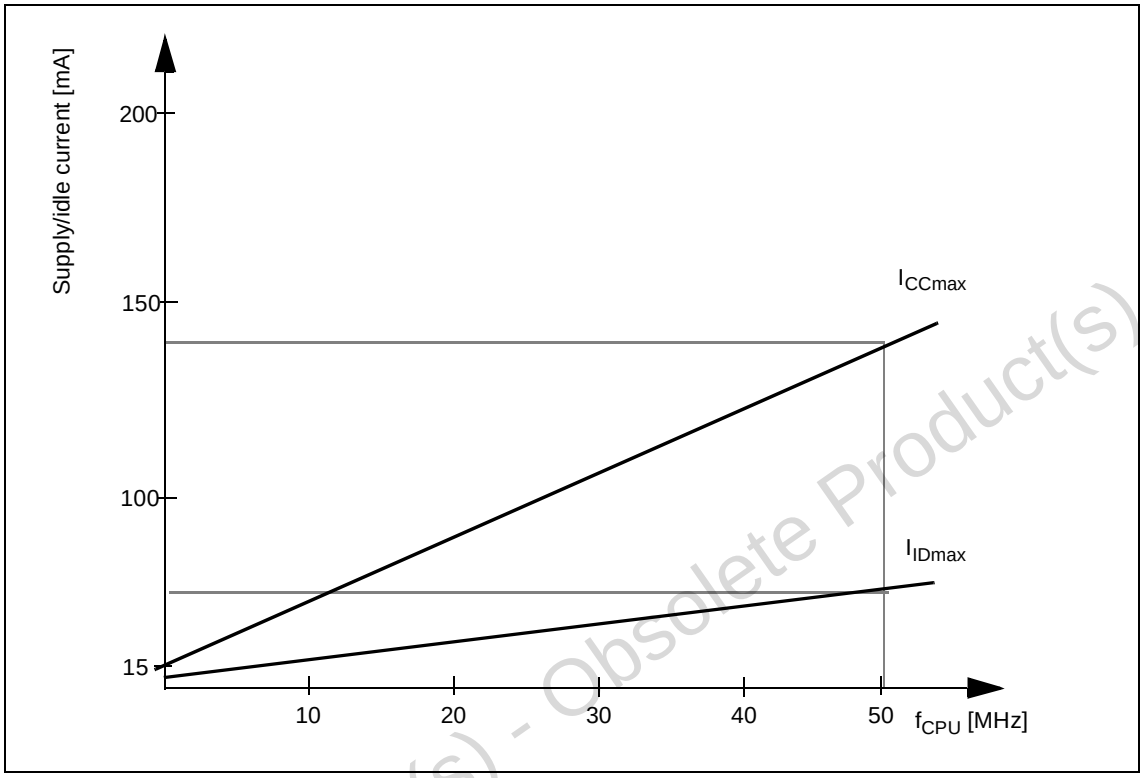


Figure 7 Supply/idle current vs operating frequency

15.3 AC Characteristics

Test conditions

- Input pulse levels: ..... 0 to +3.0 V
- Input rise and fall times (10%-90%): ..... 2.5 ns
- Input timing reference levels: ..... +1.5 V
- Output timing reference levels: ..... +1.5 V
- Output load: ..... see Figure 9

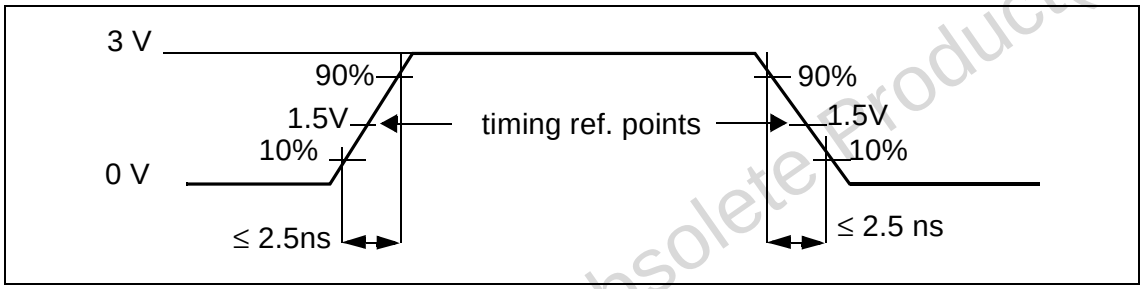


Figure 8 Input waveforms

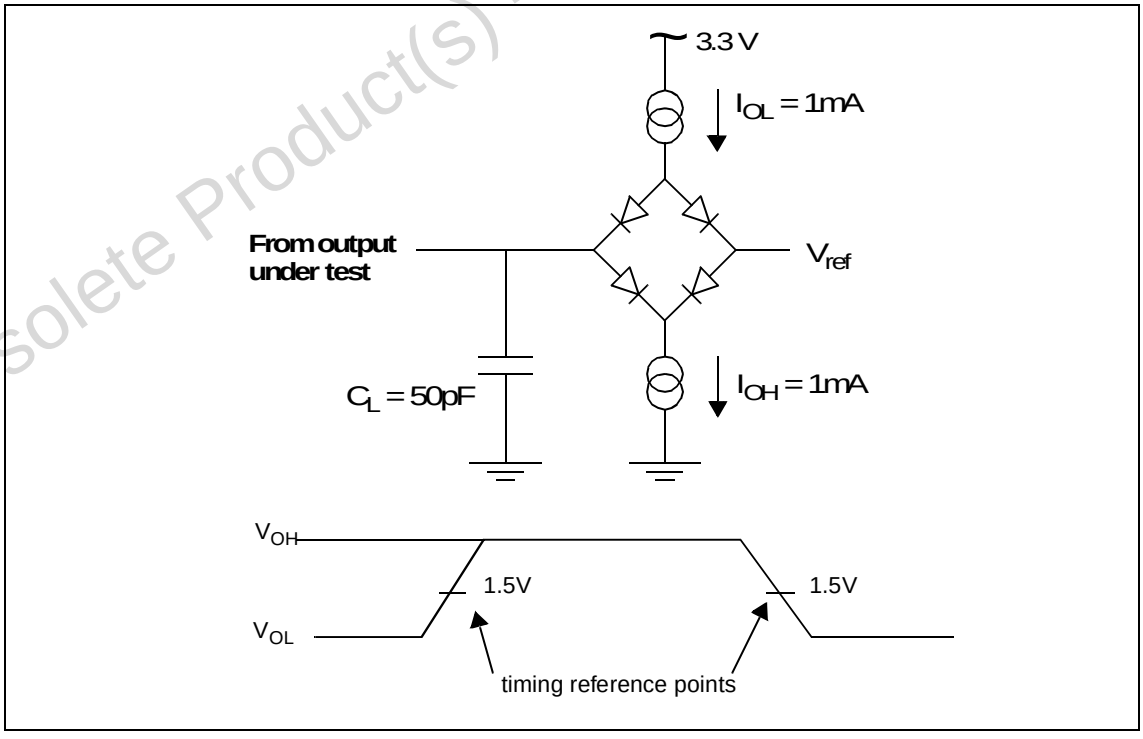
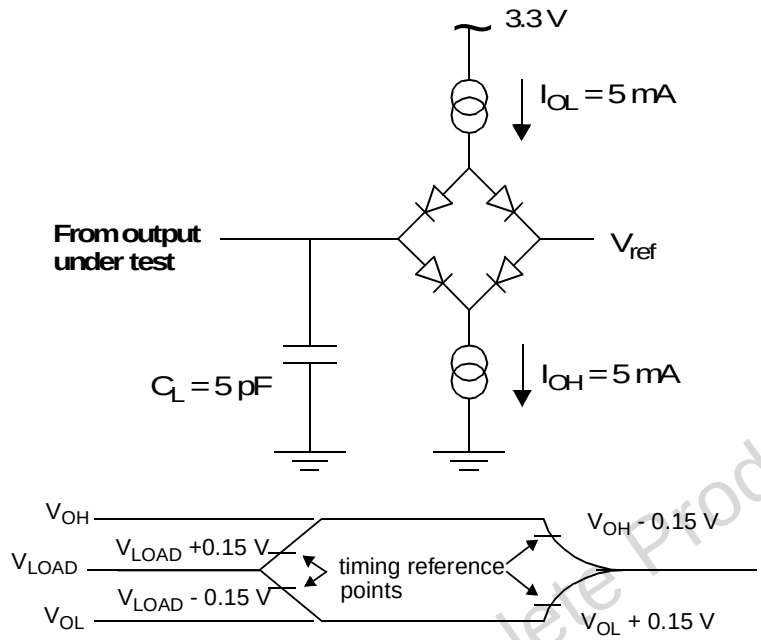


Figure 9 Output load circuit waveform



For timing purposes a port pin is no longer floating when a 150 mV change from load voltage occurs, but begins to float when a 150 mV change from the loaded VOH/VOL level occurs.

CL is 5 pF for floating measurements only.

Figure 10 Float waveforms

15.3.1 Cpu Clock Generation Mechanisms

ST10R172L internal operation is controlled by the CPU clock f_{CPU}. Both edges of the CPU clock can trigger internal (e.g. pipeline) or external (e.g. bus cycles) operations. The external timing (AC Characteristics) specification therefore depends on the time between two consecutive edges of the CPU clock, called “TCL” (see figure below).

The CPU clock signal can be generated by different mechanisms. The duration of TCLs and their variation (and also the external timing) depends on the f_{CPU} generation mechanism. This must be considered when calculating ST10R172L timing.

The CPU clock generation mechanism is set during reset by the logic levels on pins P0.15-13 (P0H.7-5).

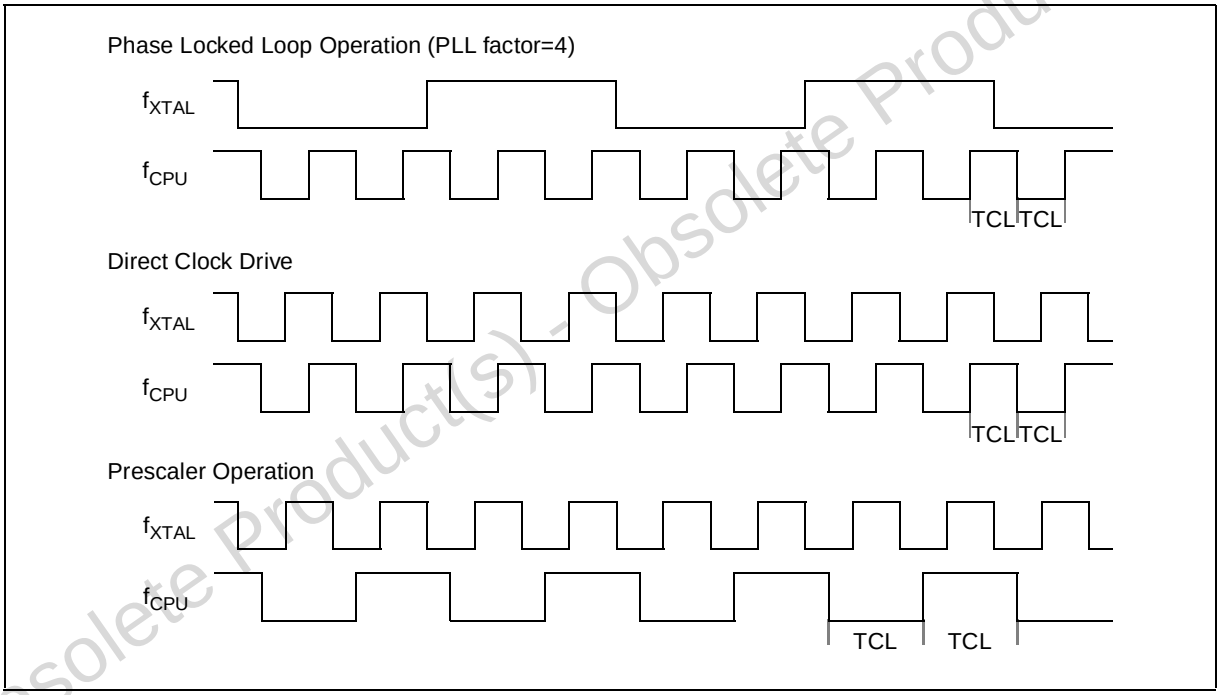


Figure 11 CPU clock generation mechanisms

P0.15-13 (P0H.7-5)			CPU frequency $f_{CPU} = f_{XTAL} * F$	External clock input range 10-50MHz	Notes
1	1	1	$F_{XTAL} * 4$	2.5 to 12.5 MHz	Default configuration
1	1	0	$F_{XTAL} * 3$	3.33 to 16.66 MHz	
1	0	1	$F_{XTAL} * 2$	5 to 25 MHz	

Table 12 CPU clock generation mechanisms

P0.15-13 (P0H.7-5)			CPU frequency $f_{CPU} = f_{XTAL} * F$	External clock input range 10-50MHz	Notes
1	0	0	$F_{XTAL} * 5$	2 to 10 MHz	
0	1	1	$F_{XTAL} * 1$	1 to 50 MHz	Direct drive 1)
0	1	0	$F_{XTAL} * 1.5$	6.66 to 33.33 MHz	
0	0	1	$F_{XTAL} / 2$	2 to 100 MHz	CPU clock via 2:1 prescaler
0	0	0	$F_{XTAL} * 2.5$	4 to 20 MHz	

Table 12 CPU clock generation mechanisms

1) The maximum depends on the duty cycle of the external clock signal. The maximum input frequency is 25 MHz when using an external crystal oscillator, but higher frequencies can be applied with an external clock source.

Prescaler operation

Set when pins P0.15-13 (P0H.7-5) equal '001' during reset, the CPU clock is derived from the internal oscillator (input clock signal) by a 2:1 prescaler.
The frequency of f_{CPU} is half the frequency of f_{XTAL} and the high and low time of f_{CPU} (i.e. the duration of an individual TCL) is defined by the period of the input clock f_{XTAL}.

The timings listed in the AC characteristics that refer to TCLs therefore can be calculated using the period of f_{XTAL} for any TCL.

Note that if the bit OWDDIS in SYSCON register is cleared, the PLL runs on its free-running frequency and delivers the clock signal for the Oscillator Watchdog. If bit OWDDIS is set, then the PLL is switched off.

Direct drive

When pins P0.15-13 (P0H.7-5) equal '011' during reset, the on-chip phase locked loop is disabled and the CPU clock is driven from the internal oscillator with the input clock signal. The frequency of f_{CPU} directly follows the frequency of f_{XTAL} so the high and low time of f_{CPU} (i.e. the duration of an individual TCL) is defined by the duty cycle of the input clock f_{XTAL}.

The TCL timing below must be calculated using the minimum possible TCL which can be calculated by the formula: $TCL_{min} = 1/f_{XTAL} \times DC_{min} (DC = \text{duty cycle})$

For two consecutive TCLs the deviation caused by the duty cycle of f_{XTAL} is compensated so the duration of 2TCL is always $1/f_{XTAL}$. Therefore, the minimum value TCL_{min} has to be used only once for timings that require an odd number of TCLs (1,3,...). Timings that require an even number of TCLs (2,4,...) may use the formula: $2TCL = 1/f_{XTAL}$.

Note *The address float timings in Multiplexed bus mode (t_{11} and t_{45}) use* $TCL_{max} = 1/f_{XTAL} \times DC_{max}$ *instead of* TCL_{min}.

Note that if the bit OWDDIS in SYSCON register is cleared, the PLL runs on its free-running frequency and delivers the clock signal for the Oscillator Watchdog. If bit OWDDIS is set, then the PLL is switched off.

Oscillator Watchdog (OWD)

When the clock option selected is direct drive or direct drive with prescaler, in order to provide a fail safe mechanism in case of a loss of the external clock, an oscillator watchdog is implemented as an additional functionality of the PLL circuitry. This oscillator watchdog operates as follows:

After a reset, the Oscillator Watchdog is enabled by default. To disable the OWD, set bit 4 of SYSCON register OWDDIS.

When the OWD is enabled, the PLL runs on its free-running frequency and increments the Oscillator Watchdog counter. On each transition of the XTAL1 pin, the Oscillator Watchdog is cleared. If an external clock failure occurs, then the Oscillator Watchdog counter overflows (after 16 PLL clock cycles). The CPU clock signal will be switched to the PLL free-running clock signal, and the Oscillator Watchdog Interrupt Request (XP3INT) is flagged. The CPU clock will not switch back to the external clock even if a valid external clock exits on XTAL1 pin. Only a hardware reset can switch the CPU clock source back to direct clock input.

When the OWD is disabled, the CPU clock is always fed from the oscillator input and the PLL is switched off to decrease power supply current.

Phase locked loop

For all other combinations of pins P0.15-13 (P0H.7-5) during reset the on-chip phase locked loop is enabled and provides the CPU clock. The PLL multiplies the input frequency by the factor F which is selected via the combination of pins P0.15-13 (i.e. $f_{CPU} = f_{XTAL} * F$). With every F'th transition of f_{XTAL} the PLL circuit synchronizes the CPU clock to the input clock. In this way, f_{CPU} is constantly adjusted so it is locked to f_{XTAL}. The slight variation causes a jitter of f_{CPU} which affects individual TCL duration.Therefore, AC characteristics that refer to TCLs must be calculated using the minimum possible TCL.

The actual minimum value for TCL depends on the jitter of the PLL. As the PLL constantly adjusts its output frequency, it corresponds to the applied input frequency (crystal or oscillator). The relative deviation for periods of more than one TCL is lower than for one single TCL. For a period of *N* * TCL the minimum value is computed using the corresponding deviation D_N:

$$TCL_{min} = TCL_{NOM} \times (1 - |D_N| / 100)$$

$$D_N = \pm(4 - N/15)[\%]$$

where ***N*** = number of consecutive TCLs and $1 \leq N \leq 40$. So for a period of 3 TCLs (i.e. $N = 3$):

$$D_3 = 4 - 3/15$$
$$= 3{,}8\%$$

and

$$3TCL_{min} = 3TCL_{NOM} \times (1 - 3{,}8/100)$$
$$= 3TCL_{NOM} \times 0{,}962 (36.07\text{nsec @fcpu=50MHz})$$

PLL jitter is an important factor for bus cycles using waitstates and for the operation of timers, serial interfaces, etc. For slower operations and longer periods (e.g. pulse train generation or measurement, lower baudrates, etc.) the deviation caused by the PLL jitter is negligible.

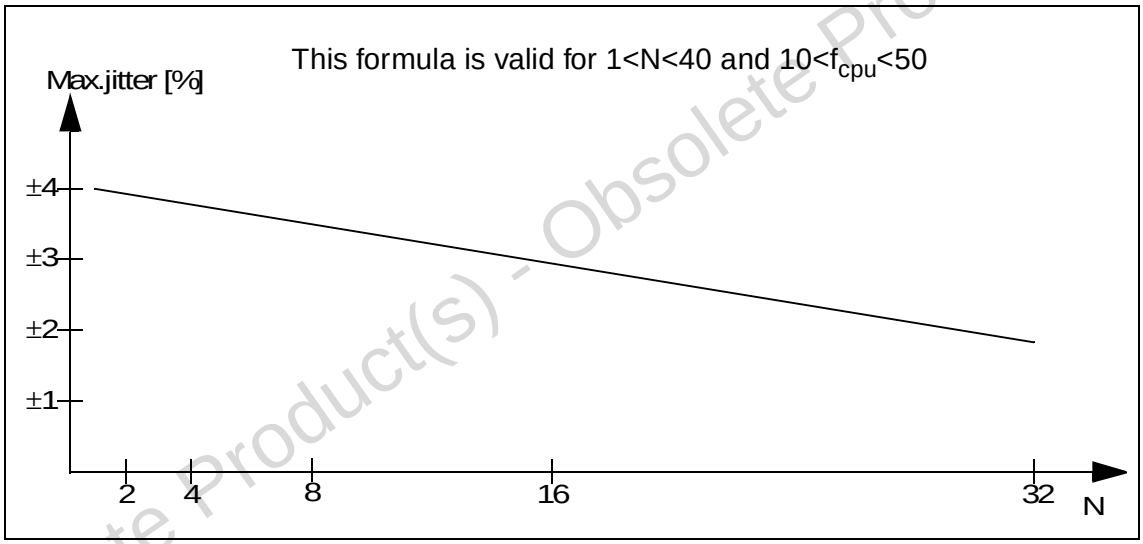


Figure 12 Approximated maximum PLL jitter

15.3.2 Memory Cycle Variables

The timing tables below use three variables derived from the BUSCONx registers and represent programmed memory cycle characteristics. Table 13 describes how these variables are computed.

Description	Symbol	Values
ALE Extension	t_A	TCL * <ALECTL>
Memory Cycle Time Waitstates	t_C	2TCL * (15 - <MCTC>)
Memory Tristate Time	t_F	2TCL * (1 - <MTTC>)

Table 13 Memory cycle variables

15.3.3 Multiplexed Bus

V_{DD} = 3.3 V ± 0.3 V V_{SS} = 0 V T_A = -40°C to +85 °C C_L = 50 pF

ALE cycle time = 6 TCL + $2t_A$ + t_C + t_F (60 ns at 50-MHz CPU clock without waitstates)

Parameter	Symbol		Max. CPU Clock = 50 MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
ALE high time	t_5	CC	7 + t_A	–	TCL - 3 + t_A	–	ns
Address (P1, P4), $\overline{BHE}$ setup to ALE	t_6	CC	3 + t_A	–	TCL - 7 + t_A	–	ns
Address (P0) setup to ALE	t_{6m}	CC	5 + t_A	–	TCL - 5 + t_A	–	ns
Address hold after ALE	t_7	CC	5 + t_A	–	TCL - 5 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (with RW-delay)	t_8	CC	5 + t_A	–	TCL - 5 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (no RW-delay)	t_9	CC	-5 + t_A	–	-5 + t_A	–	ns
Address float after $\overline{RD}$, (with RW-delay)[1)]	t_{10}	CC	–	5[1]	–	5[1]	ns
Address float after $\overline{RD}$, (no RW-delay)[1]	t_{11}	CC	–	15[1]	–	TCL + 5[1]	ns
$\overline{RD}$, $\overline{WR}$ low time (with RW-delay)	t_{12}	CC	13 + t_C	–	2TCL - 7+ t_C	–	ns
$\overline{RD}$, $\overline{WR}$ low time (no RW-delay)	t_{13}	CC	23 + t_C	–	3TCL - 7 + t_C	–	ns
$\overline{RD}$ to valid data in (with RW-delay)	t_{14}	SR	–	5 + t_C	–	2TCL - 15 + t_C	ns
$\overline{RD}$ to valid data in (no RW-delay)	t_{15}	SR	–	15 + t_C	–	3TCL - 15 + t_C	ns
ALE low to valid data in	t_{16}	SR	–	15 + t_A + t_C	–	3TCL - 15 + t_A + t_C	ns
Address to valid data in	t_{17}	SR	–	20 + $2t_A$ + t_C	–	4TCL - 20 + $2t_A$ + t_C	ns

Table 14 Multiplexed bus

Parameter	Symbol		Max. CPU Clock = 50 MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
Data hold after $\overline{RD}$ rising edge	t_{18}	SR	0	–	0	–	ns
Data float after $\overline{RD}$ rising edge 12))	t_{19}	SR	–	15 + t_F[2]	–	2TCL - 5 + t_F[2]	ns
Data valid to $\overline{WR}$	t_{22}	CC	13 + t_C	–	2TCL - 7 + t_C	–	ns
Data hold after $\overline{WR}$	t_{23}	CC	13 + t_F	–	2TCL - 7+ t_F	–	ns
ALE rising edge after $\overline{RD}$, $\overline{WR}$	t_{25}	CC	10 + t_F	–	2TCL - 10 + t_F	–	ns
Address hold after $\overline{RD}$, $\overline{WR}$	t_{27}	CC	10 + t_F	–	2TCL - 10 + t_F	–	ns
Latched $\overline{CS}$ setup to ALE	t_{38}	CC	-7 + t_A	3 + t_A	-7 + t_A	3 + t_A	ns
Unlatched $\overline{CS}$ setup to ALE	t_{38u}	CC	3 + t_A	–	TCL - 7 + t_A	–	ns
Latched $\overline{CS}$ low to Valid Data In	t_{39}	SR	–	13 + t_C + 2t_A	–	3TCL - 17 + t_C + 2t_A	ns
Unlatched $\overline{CS}$ low to Valid Data In	t_{39u}	SR	–	23 + t_C + 2t_A	–	4TCL - 17 + t_C + 2t_A	ns
Latched $\overline{CS}$ hold after $\overline{RD}$, $\overline{WR}$	t_{40}	CC	20 + t_F	–	3TCL - 10 + t_F	–	ns
Unlatched $\overline{CS}$ hold after $\overline{RD}$, $\overline{WR}$	t_{40u}	CC	10 + t_F	–	2TCL - 10 + t_F	–	ns
ALE fall. edge to $\overline{RdCS}$, $\overline{WrCS}$ (with RW delay)	t_{42}	CC	7 + t_A	–	TCL - 3 + t_A	–	ns
ALE fall. edge to $\overline{RdCS}$, $\overline{WrCS}$ (no RW delay)	t_{43}	CC	-3 + t_A	–	-3 + t_A	–	ns
Address float after $\overline{RdCS}$ (with RW delay)[1]	t_{44}	CC	–	3[1]	–	3[1]	ns
Address float after $\overline{RdCS}$ (no RW delay)[1]	t_{45}	CC	–	13[1]	–	TCL + 3[1]	ns

Table 14 Multiplexed bus

Parameter	Symbol		Max. CPU Clock = 50 MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
$\overline{RdCS}$ to Valid Data In (with RW delay)	t_{46}	SR	–	3 + t_C	–	2TCL - 17 + t_C	ns
$\overline{RdCS}$ to Valid Data In (no RW delay)	t_{47}	SR	–	13 + t_C	–	3TCL - 17 + t_C	ns
$\overline{RdCS}$, $\overline{WrCS}$ Low Time (with RW delay)	t_{48}	CC	13 + t_C	–	2TCL - 7+ t_C	–	ns
$\overline{RdCS}$, $\overline{WrCS}$ Low Time (no RW delay)	t_{49}	CC	23 + t_C	–	3TCL - 7+ t_C	–	ns
Data valid to $\overline{WrCS}$	t_{50}	CC	10 + t_C	–	2TCL - 10 + t_C	–	ns
Data hold after $\overline{RdCS}$	t_{51}	SR	0	–	0	–	ns
Data float after $\overline{RdCS}$[1 2]	t_{52}	SR	–	13 + t_F[2]	–	2TCL - 7 + t_F[2]	ns
Address hold after $\overline{RdCS}$, $\overline{WrCS}$	t_{54}	CC	10 + t_F	–	2TCL - 10 + t_F	–	ns
Data hold after $\overline{WrCS}$	t_{56}	CC	10 + t_F	–	2TCL - 10 + t_F	–	ns

Table 14 Multiplexed bus

1) Output loading is specified using Figure 10 (CL = 5 pF).

2) This delay assumes that the following bus cycle is a multiplexed bus cycle. If next bus cycle is demultiplexed, refer to demuxultiplexed equivalent AC timing.

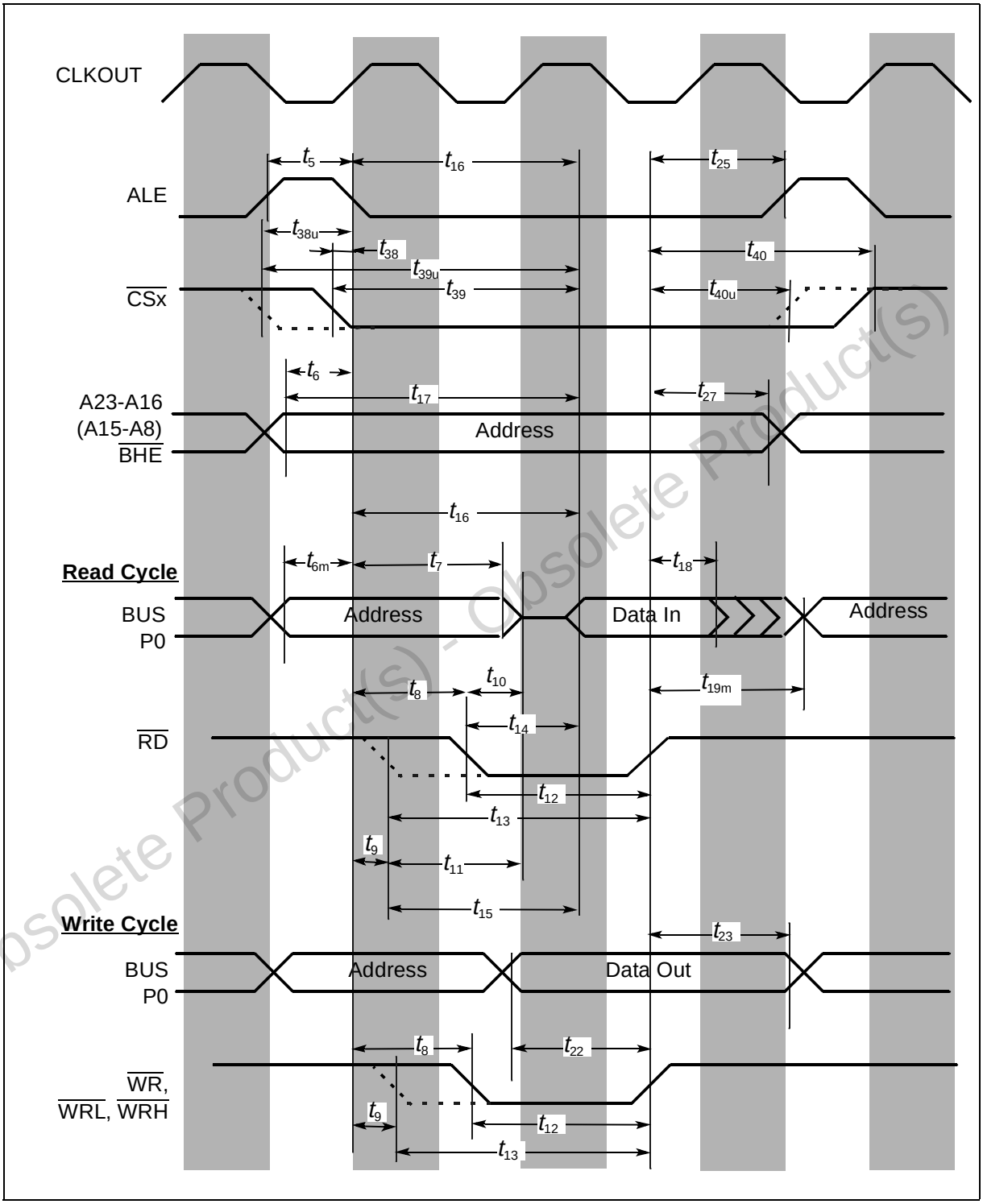


Figure 13 External memory cycle:
multiplexed bus, with/without read/write delay, normal ALE

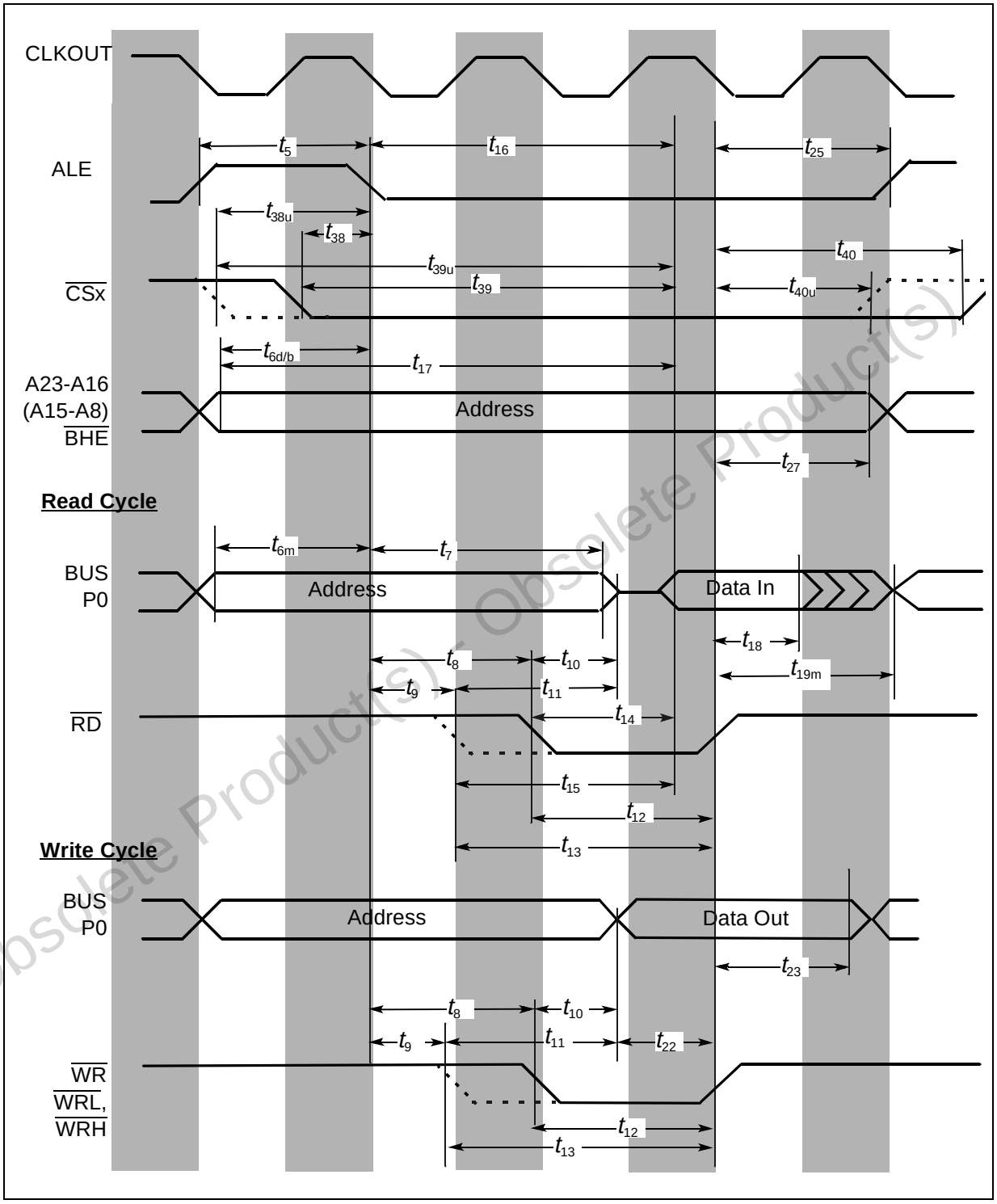


Figure 14 External memory cycle:
multiplexed bus, with/without read/write delay, extended ALE

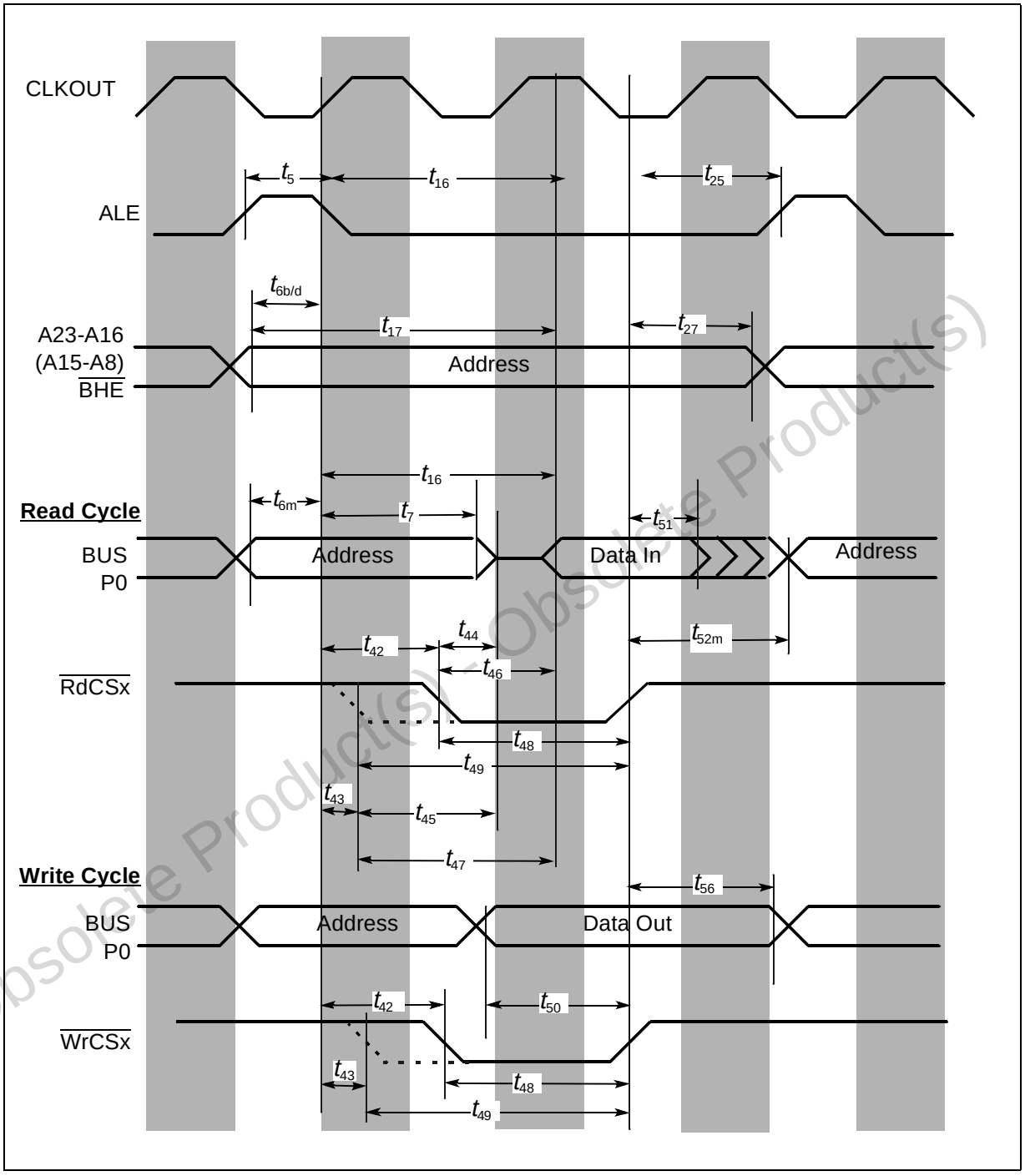


Figure 15 External memory cycle:
multiplexed bus, with/without read/write delay, normal ALE, read/write chip select

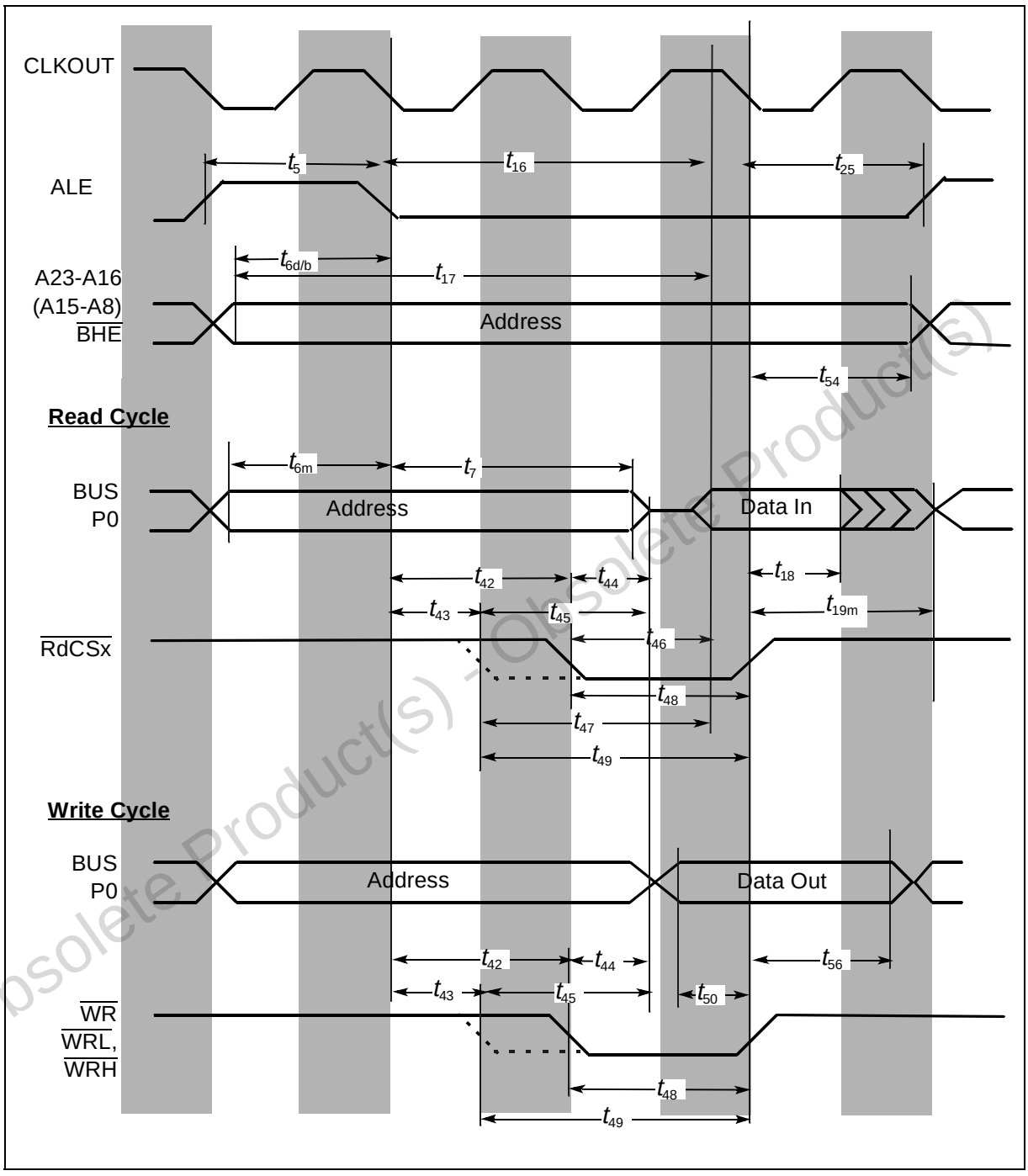


Figure 16 External memory cycle:
multiplexed bus, with/without read/write delay, extended ale, read/write chip select

15.3.4 Demultiplexed Bus

V_{DD} = 3.3 V ± 0.3 V V_{SS} = 0 V T_A = -40°C to +85 °C C_L = 50 pF

ALE cycle time = 4 TCL + $2t_A$ + t_C + t_F (40 ns at 50 MHz CPU clock without waitstates)

Parameter	Symbol		Max CPU Clock 50MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
ALE high time	t_5	CC	7 + t_A	–	TCL - 3 + t_A	–	ns
Address (P1, P4), $\overline{BHE}$ setup to ALE	t_6	CC	3 + t_A	–	TCL - 7 + t_A	–	ns
Address setup to $\overline{RD}$, $\overline{WR}$ (with RW-delay)	t_{80}	CC	13 + $2t_A$	–	2TCL - 7 + $2t_A$	–	ns
Address setup to $\overline{RD}$, $\overline{WR}$ (no RW-delay)	t_{81}	CC	3 + $2t_A$	–	TCL - 7 + $2t_A$	–	ns
$\overline{RD}$, $\overline{WR}$ low time (with RW-delay)	t_{12}	CC	13 + t_C	–	2TCL - 7 + t_C	–	ns
$\overline{RD}$, $\overline{WR}$ low time (no RW-delay)	t_{13}	CC	23 + t_C	–	3TCL - 7 + t_C	–	ns
$\overline{RD}$ to valid data in (with RW-delay)	t_{14}	SR	–	5 + t_C	–	2TCL - 15 + t_C	ns
$\overline{RD}$ to valid data in (no RW-delay)	t_{15}	SR	–	15 + t_C	–	3TCL - 15 + t_C	ns
ALE low to valid data in	t_{16}	SR	–	15 + t_A + t_C	–	3TCL - 15 + t_A + t_C	ns
Address to valid data in	t_{17}	SR	–	20 + $2t_A$ + t_C	–	4TCL - 20 + $2t_A$ + t_C	ns
Data hold after $\overline{RD}$ rising edge	t_{18}	SR	0	–	0	–	ns
Data float after $\overline{RD}$ rising edge (with RW-delay)[1) 2)]	t_{20}	SR	–	15 + t_F + $2t_A$[2]	–	2TCL - 5 + t_F + $2t_A$[2]	ns
Data float after $\overline{RD}$ rising edge (no RW-delay)[1 2]	t_{21}	SR	–	5 + t_F + $2t_A$[2]	–	TCL - 5 + t_F + $2t_A$[2]	ns
Data valid to $\overline{WR}$	t_{22}	CC	13 + t_C	–	2TCL - 7 + t_C	–	ns

Table 15 Demultiplexed bus

Parameter	Symbol		Max CPU Clock 50MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
Data hold after $\overline{WR}$	t_{24}	CC	5 + t_F	–	TCL - 5 + t_F	–	ns
ALE rising edge after $\overline{RD}$, $\overline{WR}$	t_{26}	CC	-5 + t_F	–	-5 + t_F	–	ns
Address hold after $\overline{RD}$, $\overline{WR}$	t_{28}	CC	0 (no t_F) -9+t_F ($t_{F>0}$)	–	0 (no t_F) -9+ t_F ($t_{F>0}$)	–	ns
Address hold after $\overline{WRH}$	t_{28h}	CC	-1 (no t_F) -8 +t_F ($t_{F>0}$)	–	-1 (no t_F) -8 + t_F ($t_{F>0}$)	–	ns
Latched $\overline{CS}$ setup to ALE	t_{38}	CC	-7 + t_A	3 + t_A	-7 + t_A	3 + t_A	ns
Unlatched $\overline{CS}$ setup to ALE	t_{38u}	CC	3 + t_A	–	TCL - 7 + t_A	–	ns
Latched $\overline{CS}$ low to Valid Data In	t_{39}	SR	–	13 + t_C + 2t_A	–	3TCL - 17 + t_C + 2t_A	ns
Unlatched $\overline{CS}$ low to Valid Data In	t_{39u}	SR	–	23 + t_C + 2t_A	–	4TCL - 17 + t_C + 2t_A	ns
Latched $\overline{CS}$ hold after $\overline{RD}$, $\overline{WR}$	t_{41}	CC	3 + t_F	–	TCL - 7 + t_F	–	ns
Unlatched $\overline{CS}$ hold after $\overline{RD}$, $\overline{WR}$	t_{41u}	CC	0 (no t_F) -7 +t_F ($t_{F>0}$)	–	0 (no t_F) -7 + t_F ($t_{F>0}$)	–	ns
Address setup to $\overline{RdCs}$, $\overline{WrCs}$ (with RW-delay)	t_{82}	CC	13 + 2t_A	–	2TCL - 7 + 2t_A	–	ns
Address setup to $\overline{RdCs}$, $\overline{WrCs}$ (no RW-delay)	t_{83}	CC	3 + 2t_A	–	TCL - 7 + 2t_A	–	ns
$\overline{RdCS}$ to Valid Data In (with RW-delay)	t_{46}	SR	–	3 + t_C	–	2TCL - 17 + t_C	ns
$\overline{RdCS}$ to Valid Data In (no RW-delay)	t_{47}	SR	–	13 + t_C	–	3TCL - 17 + t_C	ns
$\overline{RdCS}$, $\overline{WrCS}$ Low Time (with RW-delay)	t_{48}	CC	11 + t_C	–	2TCL - 9 + t_C	–	ns
$\overline{RdCS}$, $\overline{WrCS}$ Low Time (no RW-delay)	t_{49}	CC	21 + t_C	–	3TCL - 9 + t_C	–	ns
Data valid to $\overline{WrCS}$	t_{50}	CC	13 + t_C	–	2TCL - 7 + t_C	–	ns

Table 15 Demultiplexed bus

Parameter	Symbol		Max CPU Clock 50MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
Data hold after $\overline{RdCS}$	t_{51}	SR	0	–	0	–	ns
Data float after $\overline{RdCS}$ (with RW-delay)[1 2]	t_{53}	SR	–	$13 + t_{F + 2tA}$[2]	–	$2TCL - 7 + t_{F + 2tA}$[2]	ns
Data float after $\overline{RdCS}$ (no RW-delay)[1 2]	t_{68}	SR	–	$3 + t_{F+ 2tA}$[2]	–	$TCL - 7 + t_{F + 2tA}$[2]	ns
Address hold after $\overline{RdCS}$, $\overline{WrCS}$	t_{55}	CC	$-5 + t_F$	–	$-5 + t_F$	–	ns
Data hold after $\overline{WrCS}$	t_{57}	CC	$3 + t_F$	–	$TCL - 7 + t_F$	–	ns

Table 15 Demultiplexed bus

1) Output loading is specified using Figure 10 with CL = 5 pF.

2) This delay assumes that the following bus cycle is a demultiplexed bus cycle and that the data bus will only be driven externally when the $\overline{RD}$ or $\overline{RdCs}$ signal becomes active. RW-delay and t_A refer to the following bus cycle. If the following bus cycle is a muxtiplexed bus cycle, refer to equivalent multiplexed AC timing (which are still applicable due to automatic insertion an idle state (2TCL) when switching from Demultiplexed to Multiplexed Bus Mode.

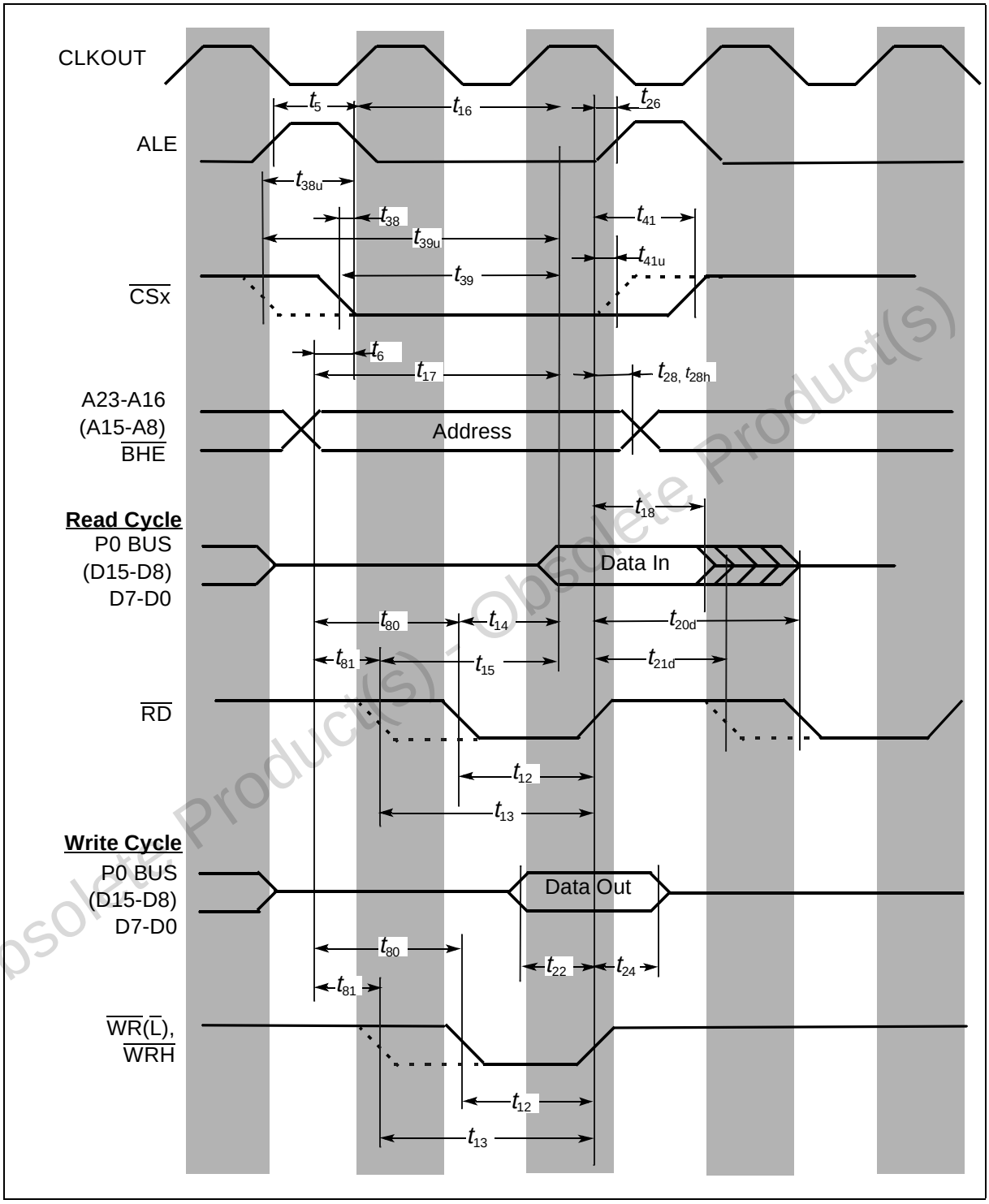


Figure 17 External memory cycle:
demultiplexed bus, with/without read/write delay, normal ALE

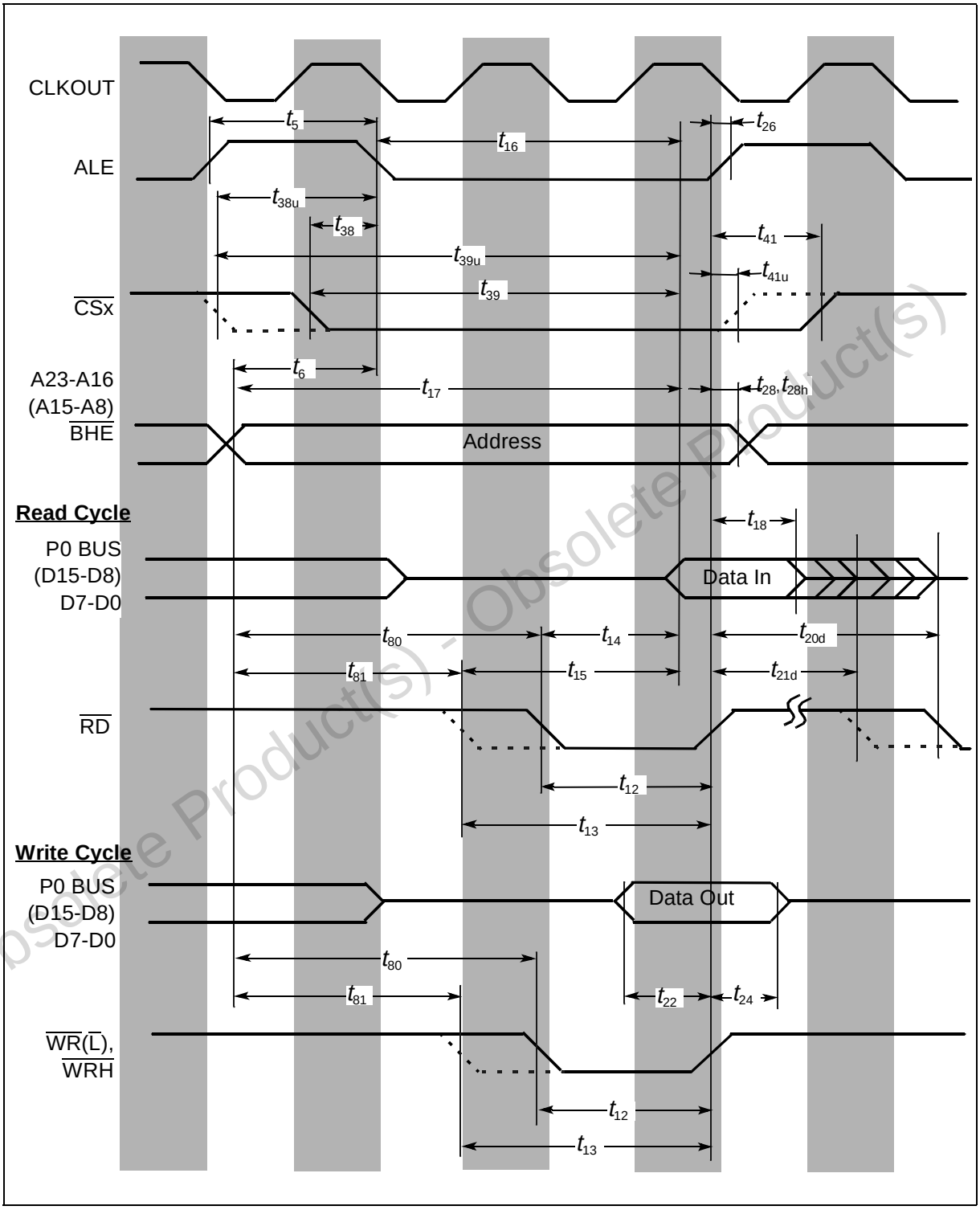


Figure 18 External memory cycle:
demultiplexed bus, with/without read/write delay, extended ALE

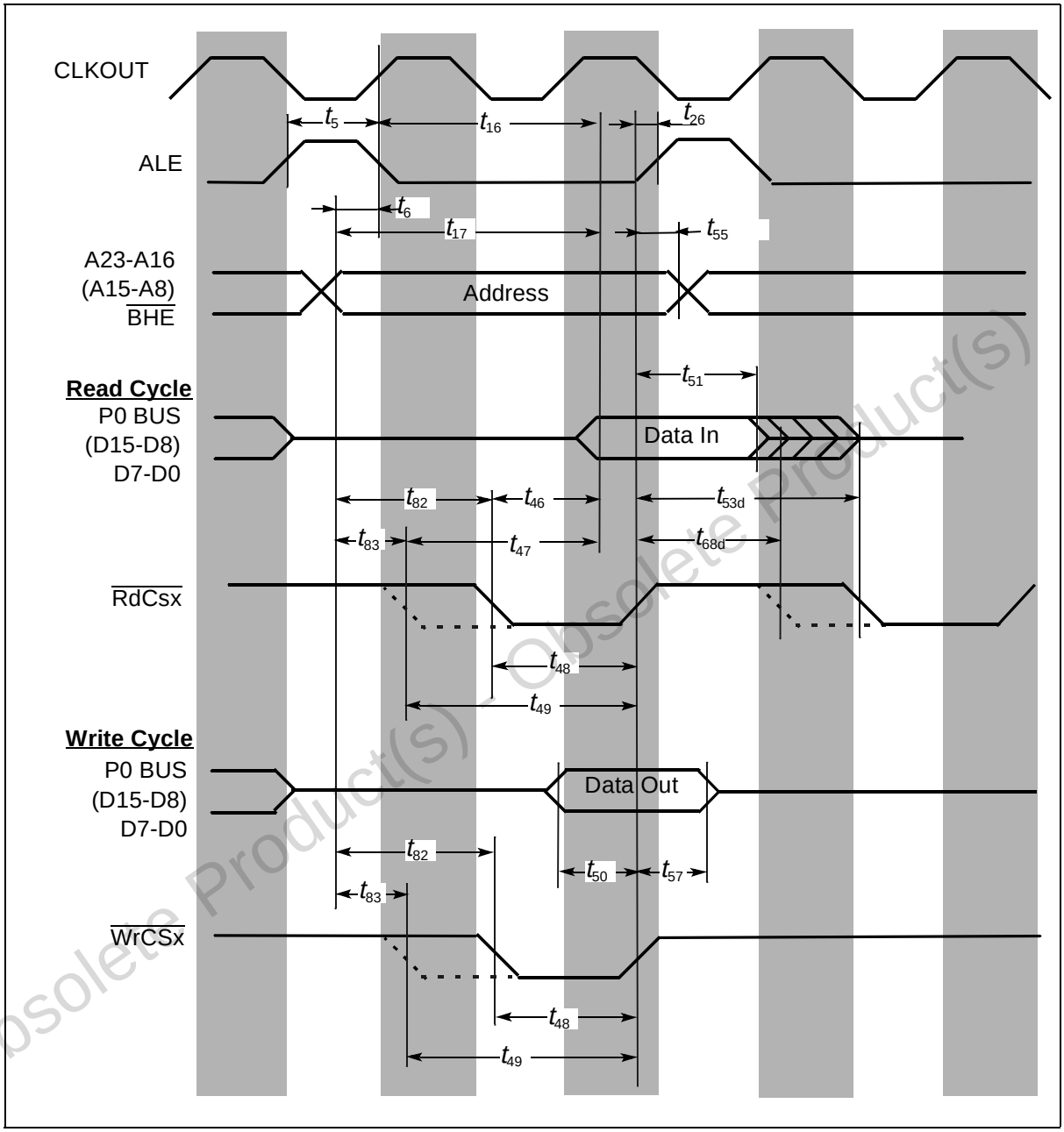


Figure 19 External memory cycle:
demultiplexed bus, with/without read/write delay, normal ALE, read/write chip select

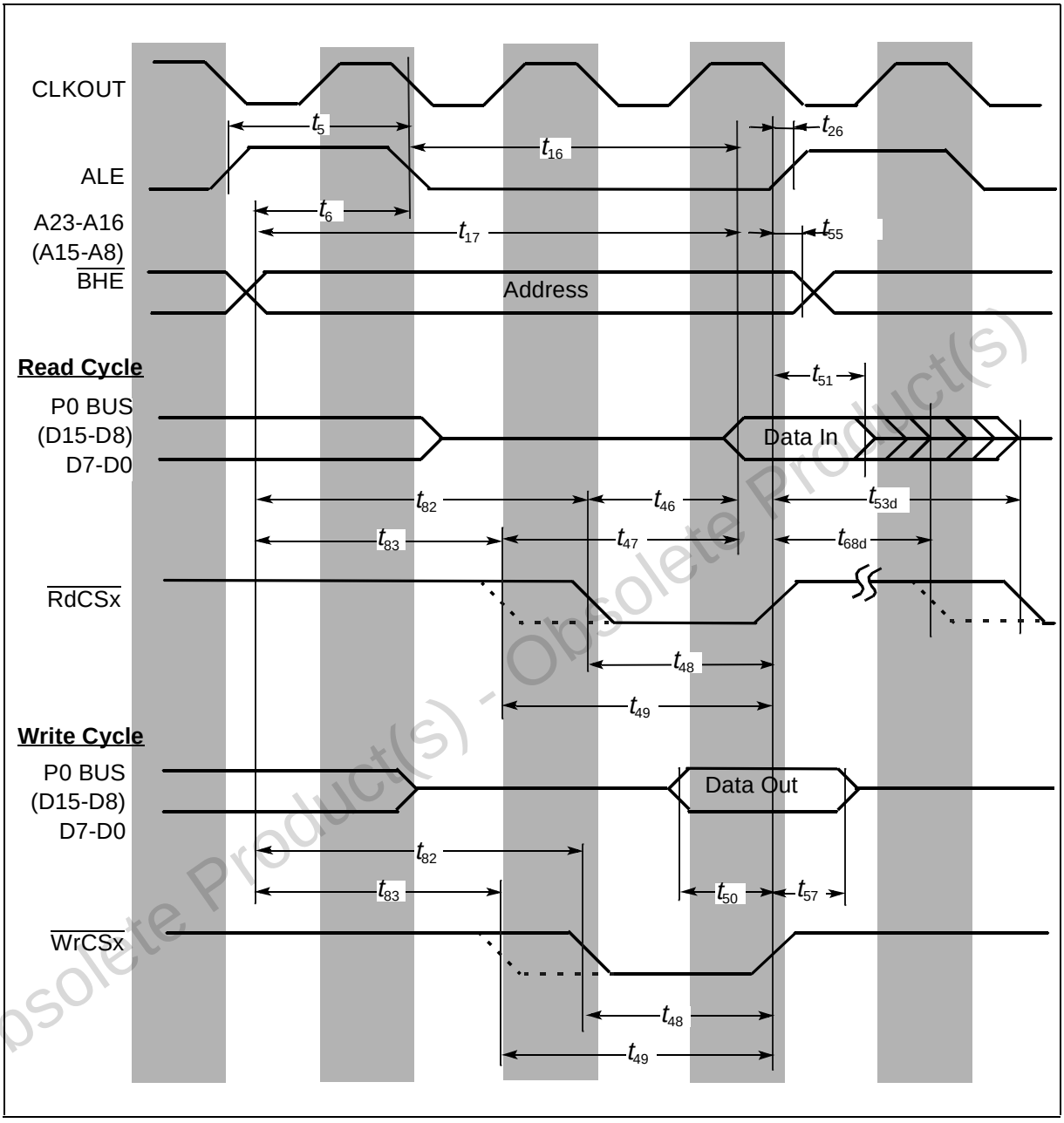


Figure 20 External memory cycle:
demultiplexed bus, no read/write delay, extended ALE, read/write chip select

15.3.5 CLKOUT and $\overline{\text{READY}}$/READY

V_{DD} = 3.3 V ± 0.3 V V_{SS} = 0 V T_A = -40°C to +85 °C C_L = 50 pF

Parameter	Symbol	Max. CPU Clock = 50 MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
		min.	max.	min.	max.	
CLKOUT cycle time	t_{29} CC	20	20	2TCL	2TCL	ns
CLKOUT high time	t_{30} CC	5	–	TCL – 5	–	ns
CLKOUT low time	t_{31} CC	5	–	TCL – 5	–	ns
CLKOUT rise time[1)]	t_{32} CC	–	3[1]	–	3[1]	ns
CLKOUT fall time[1]	t_{33} CC	–	3[1]	–	3[1]	ns
CLKOUT rising edge to ALE falling edge	t_{34} CC	-3 + t_A	5 + t_A	-3 + t_A	5 + t_A	ns
Synchronous READY setup time to CLKOUT	t_{35} SR	9	–	9	–	ns
Synchronous READY hold time after CLKOUT	t_{36} SR	0	–	0	–	ns
Asynchronous READY low time	t_{37} SR	27	–	2TCL + 7	–	ns
Asynchronous READY setup time[2)]	t_{58} SR	9	–	9	–	ns
Asynchronous READY hold time[2]	t_{59} SR	0	–	0	–	ns
Async. READY hold time after $\overline{\text{RD}}$, $\overline{\text{WR}}$ high (Demultiplexed Bus)[3)2]	t_{60} SR	0	0 + $2t_A$+ t_c+ t_F [3]	0	TCL - 10 + $2t_A$+ t_c+ t_F[3]	ns

Table 16 CLKOUT and $\overline{\text{READY}}$/READY

1) Measured between 0.3 and 2.7 volts
2) These timings assure recognition at a specific clock edge for test purposes only.
3) Demultiplexed bus is the worst case. For multiplexed bus, 2TCL should be added to the maximum values. This adds even more time for deactivating READY. $2t_A$ and t_C refer to the following bus cycle, t_F refers to the current bus cycle.

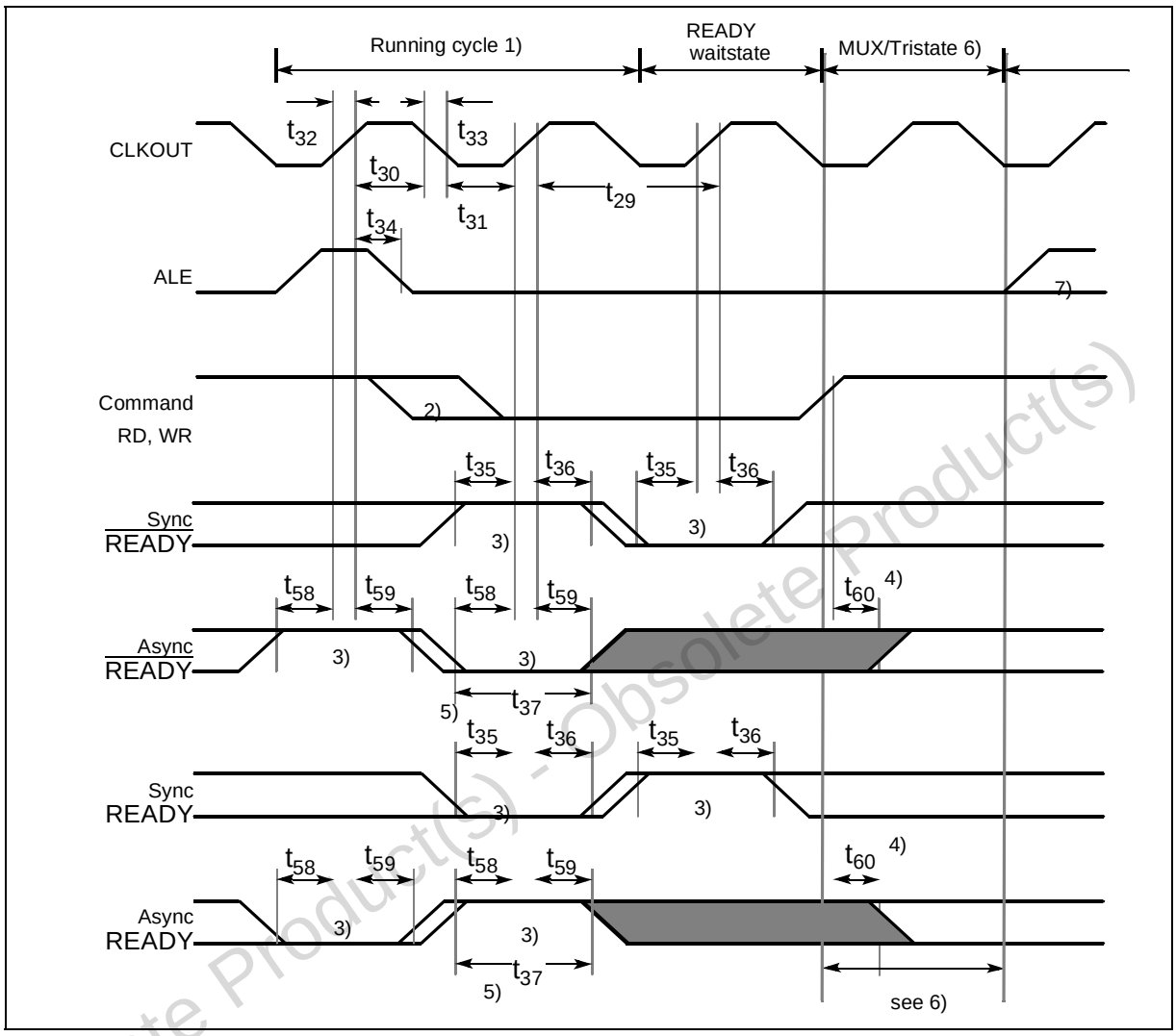


Figure 21 CLKOUT and $\overline{\text{READY}}$/READY

1 Cycle as programmed, including MCTC waitstates (Example shows 0 MCTC WS).

2 The leading edge of the respective command depends on RW-delay.

3 $\overline{\text{READY}}$ (or READY) sampled HIGH (resp. LOW) at this sampling point generates a READY controlled waitstate, $\overline{\text{READY}}$ (resp. READY) sampled LOW (resp. HIGH) at this sampling point terminates the currently running bus cycle.

4 $\overline{\text{READY}}$ (resp. READY) may be deactivated in response to the trailing (rising) edge of the corresponding command ($\overline{\text{RD}}$ or $\overline{\text{WR}}$).

5 If the Asynchronous $\overline{\text{READY}}$ (or READY) signal does not fulfill the indicated setup and hold times with respect to CLKOUT (e.g. because CLKOUT is not enabled), it must fulfill t 37 in order to be safely synchronized. This is guaranteed, if READY is removed in response to the command (see Note 4)).

6 Multiplexed bus modes have a MUX waitstate added after a bus cycle, and an additional MTTC waitstate may be inserted here. For a multiplexed bus with MTTC waitstate this delay is 2 CLKOUT cycles, for a demultiplexed bus without MTTC waitstate this delay is zero.

7 The next external bus cycle may start here.

15.3.6 External Bus Arbitration

V_{DD} = 3.3 V ± 0.3 V V_{SS} = 0 V T_A = -40°C to +85 °C C_L = 50 pF

Parameter	Symbol		Max. CPU Clock = 50 MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
$\overline{HOLD}$ input setup time to CLKOUT	t_{61}	SR	15	–	15	–	ns
CLKOUT to $\overline{HLDA}$ high or $\overline{BREQ}$ low delay	t_{62}	CC	–	10	–	10	ns
CLKOUT to $\overline{HLDA}$ low or $\overline{BREQ}$ high delay	t_{63}	CC	–	10	–	10	ns
$\overline{CSx}$ release	t_{64}	CC	–	15	–	15	ns
$\overline{CSx}$ drive	t_{65}	CC	-3	15	-3	15	ns
Other signals release	t_{66}	CC	–	15	–	15	ns
Other signals drive	t_{67}	CC	-3	15	-3	15	ns

Table 17 External bus arbitration

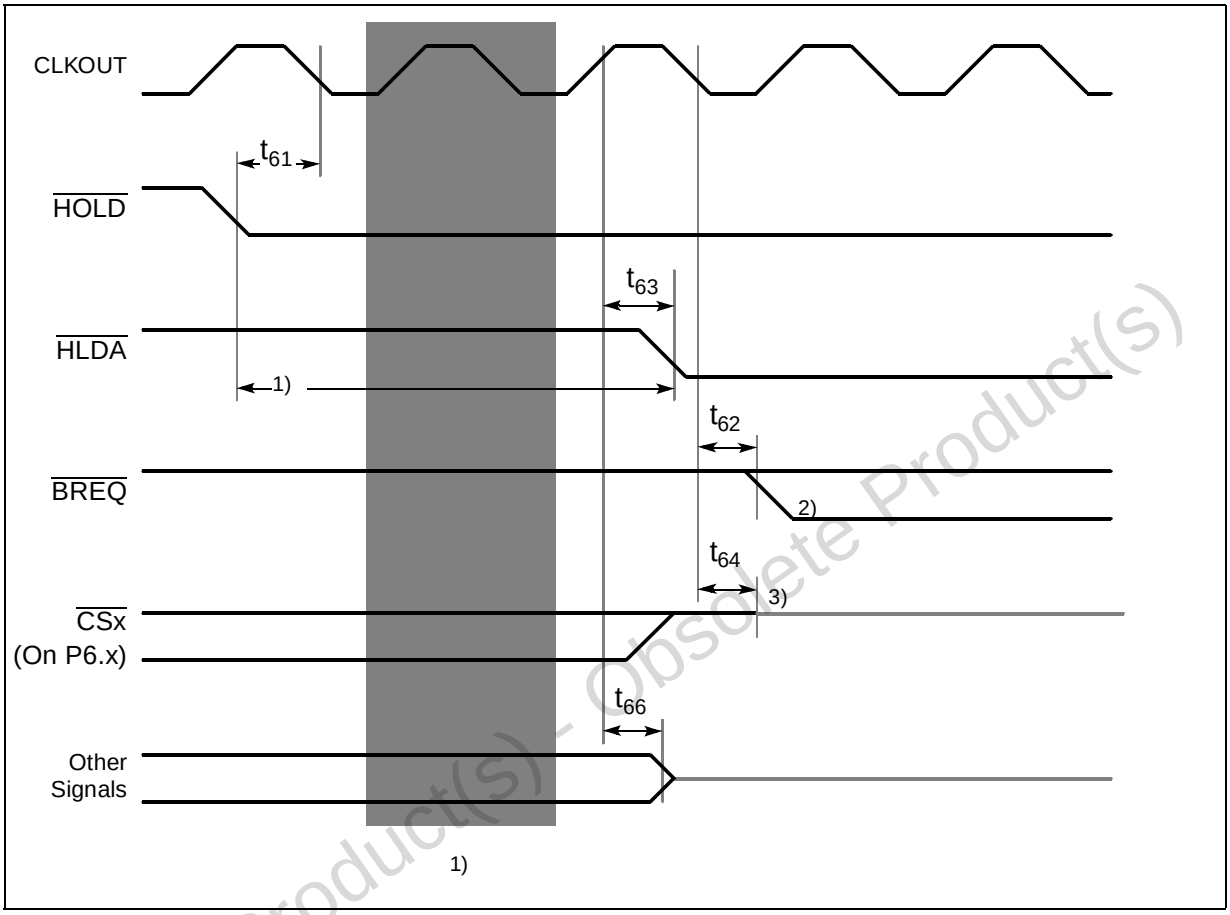


Figure 22 External bus arbitration, releasing the bus

1 The ST10R172L will complete the running bus cycle before granting bus access.

2 This is the first opportunity for $\overline{BREQ}$ to become active.

3 The $\overline{CS}$ outputs will be resistive high (pullup) after t_{64}.

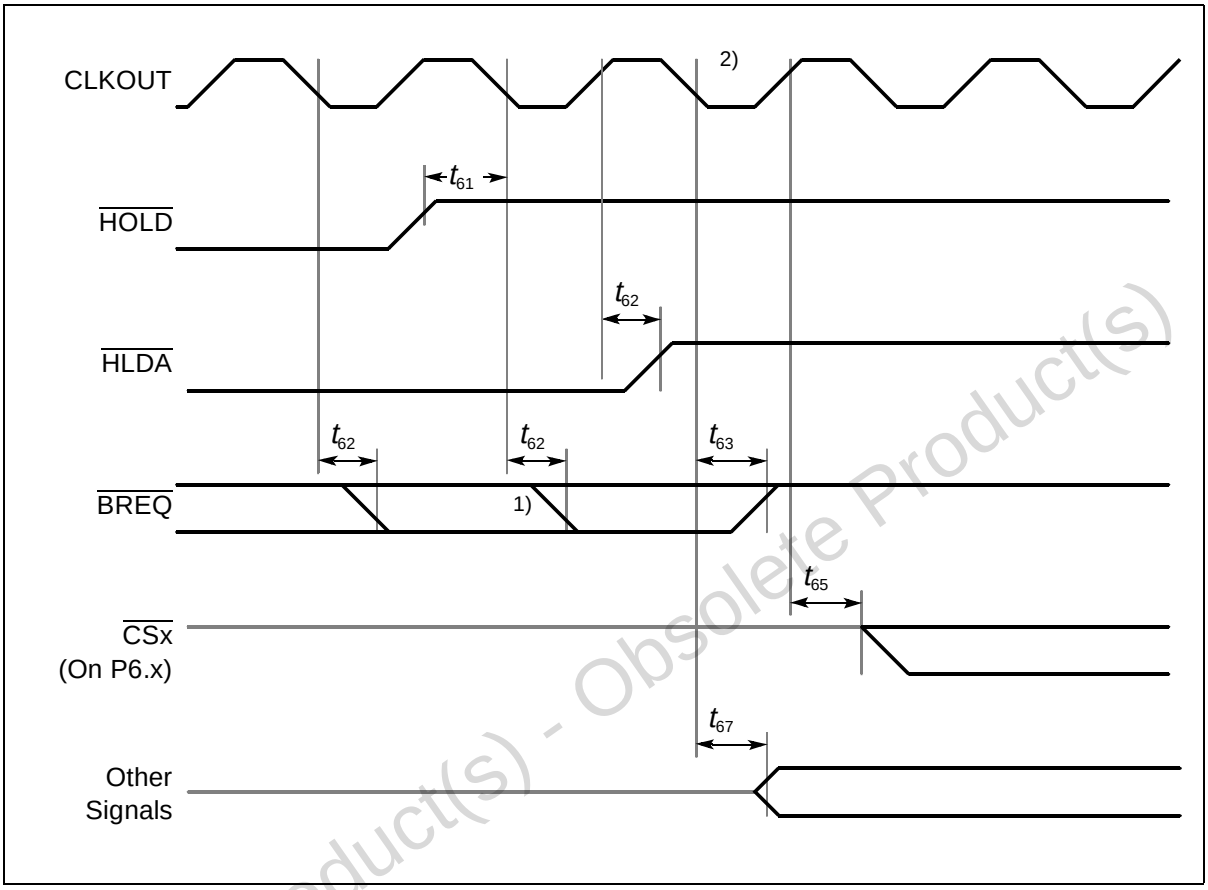


Figure 23 External bus arbitration, (regaining the bus)

1 This is the last chance for BREQ to trigger the regain-sequence indicated. Even if BREQ is activated earlier, the regain-sequence is initiated by HOLD going high. Please note that HOLD may also be de-activated without the ST10R172L requesting the bus.

2 The next ST10R172L driven bus cycle may start here.

15.3.7 External Hardware Reset

V_{DD} = 3.3 V ± 0.3 V V_{SS} = 0 V T_A = -40°C to +85 °C C_L = 50 pF

Parameter	Symbol		Max. CPU Clock = 50 MHz		Variable CPU Clock 1/2TCL = 1 to 50 MHz		Unit
			min.	max.	min.	max.	
Sync. $\overline{\text{RSTIN}}$ low time[1)]	t_{70}	SR	50	–	4 TCL + 10	–	ns
$\overline{\text{RSTIN}}$ low to internal reset sequence start	t_{71}	CC	4	16	4	16	TCL
internal reset sequence, ($\overline{\text{RSTIN}}$ internally pulled low)	t_{72}	CC	1024	1024	1024	1024	TCL
$\overline{\text{RSTIN}}$ rising edge to internal reset condition end	t_{73}	CC	4	6	4	6	TCL
PORT0 system start-up configuration setup to $\overline{\text{RSTIN}}$ rising edge [2)]	t_{74}	SR	100	–	100	–	ns
PORT0 system start-up configuration hold after $\overline{\text{RSTIN}}$ rising edge	t_{75}	SR	1	6	1	6	TCL
Bus signals drive from internal reset end	t_{76}	CC	0	20	0	20	ns
$\overline{\text{RSTIN}}$ low to signals release	t_{77}	CC	–	50	–	50	ns
ALE rising edge from internal reset condition end	t_{78}	CC	8	8	8	8	TCL
Async. $\overline{\text{RSTIN}}$ low time[1]	t_{79}	SR	1500	–	1500	–	ns

Table 18 External hardware reset

1) On power-up reset, the $\overline{\text{RSTIN}}$ pin must be asserted until a stable clock signal is available (about 10...50 ms to allow the on-chip oscillator to stabilize) and until System Start-up Configuration is correct on PORT0 (about 50 µs for internal pullup devices to load 50 pF from V_{IL}min to V_{IH}min).

2) The value of bits 0 (EMU), 1 (ADAPT), 13 to 15 (Clock Configuration) are loaded during hardware reset as long as internal reset signal is active, and have an immediate effect on the system.

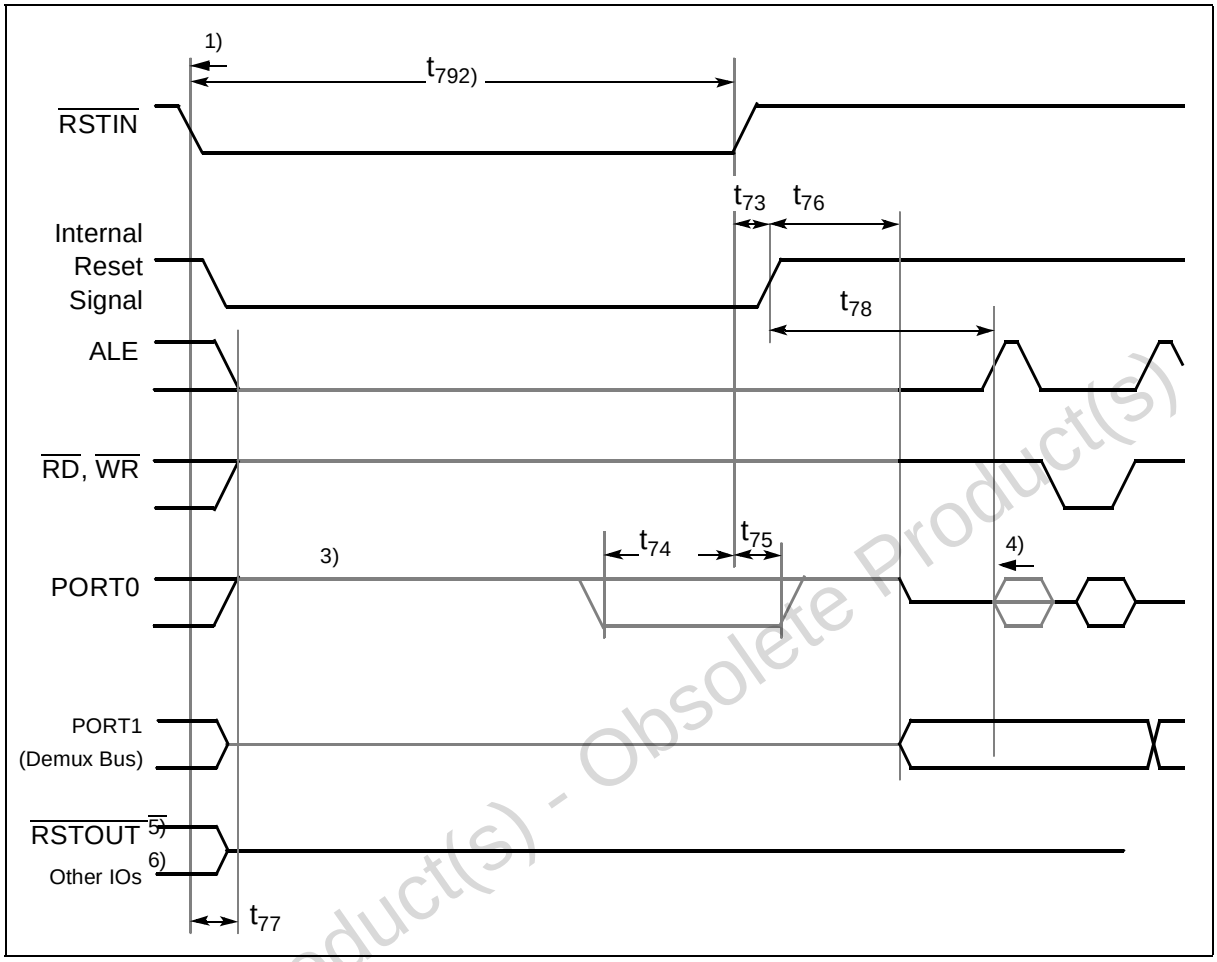


Figure 24 External asynchronous hardware reset (power-up reset): Vpp low

1 The ST10R172L is reset in its default state asynchronously with $\overline{\text{RSTIN}}$. The internal RAM content may be altered if an internal write access is in progress.

2 On power-up, $\overline{\text{RSTIN}}$ must be asserted t_{79} after a stabilized CPU clock signal is available.

3 Internal pullup devices are active on the PORT0 lines, so - input level is high if the respective pin is left open - or is low if the respective pin is connected to an external pulldown device.

4 The ST10R172L starts execution here at address 00’0000h.

5 $\overline{\text{RSTOUT}}$ stays active until execution of the EINIT (end of initialization) instruction.

6 Activation of the IO pins is controlled by software

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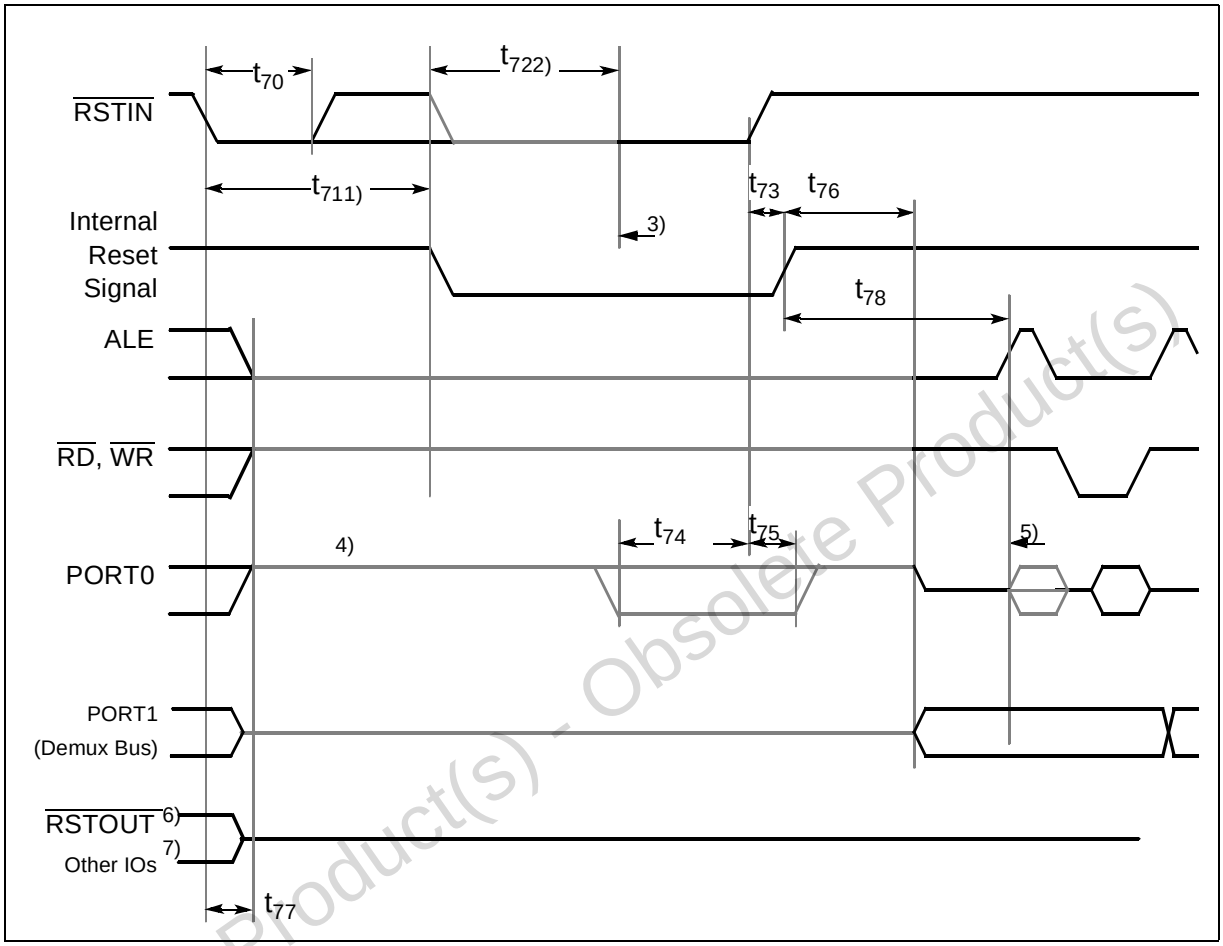


Figure 25 External synchronous hardware reset (warm reset): Vpp high

1 The pending internal hold states are cancelled and the current internal access cycle (if any) is completed.

2 $\overline{\text{RSTIN}}$ pulled low by internal device during internal reset sequence.

3 The reset condition may ends here if $\overline{\text{RSTIN}}$ pin is sampled high after t_{72}.

4 Internal pullup devices are active on the PORT0 lines. Their input level is high if the respective pin is left open, or is low if the respective pin is connected to an external pull-down device by resistive high (pullup) after t_{64}.

5 The ST10R172L starts execution here at address 00'0000h.

6 $\overline{\text{RSTOUT}}$ stays active until execution of the EINIT (End of Initialization) instruction.

7 Activation of the IO pins is controlled by software.

15.3.8 Synchronous Serial Port Timing

V_{CC} = 3.3 V ± 0.3 V V_{SS} = 0 V T_A = -40°C to +85 °C C_L = 50 pF

Parameter	Symbol		Max. Baudrate = 25 MBd		Variable Baudrate = 0.2 to 25 MBd		Unit
			min.	max.	min.	max.	
SSP clock cycle time	t_{200}	CC	40	40	4 TCL	512 TCL	ns
SSP clock high time	t_{201}	CC	13	–	$t_{200}/2$ - 7	–	ns
SSP clock low time	t_{202}	CC	13	–	$t_{200}/2$ - 7	–	ns
SSP clock rise time	t_{203}	CC	–	3	–	3	ns
SSP clock fall time	t_{204}	CC	–	3	–	3	ns
CE active before shift edge	t_{205}	CC	13	–	$t_{200}/2$ - 7	–	ns
CE inactive after latch edge	t_{206}	CC	33	47	t_{200} - 7	t_{200} + 7	ns
Write data valid after shift edge	t_{207}	CC	–	7	–	7	ns
Write data hold after shift edge	t_{208}	CC	0	–	0	–	ns
Write data hold after latch edge	t_{209}	CC	15	25	$t_{200}/2$ - 5	$t_{200}/2$ + 5	ns
Read data active after latch edge	t_{210}	SR	27	–	$t_{200}/2$ + 7	–	ns
Read data setup time before latch edge	t_{211}	SR	15	–	15	–	ns
Read data hold time after latch edge	t_{212}	SR	0	–	0	–	ns

Table 19 Synchronous serial port timing

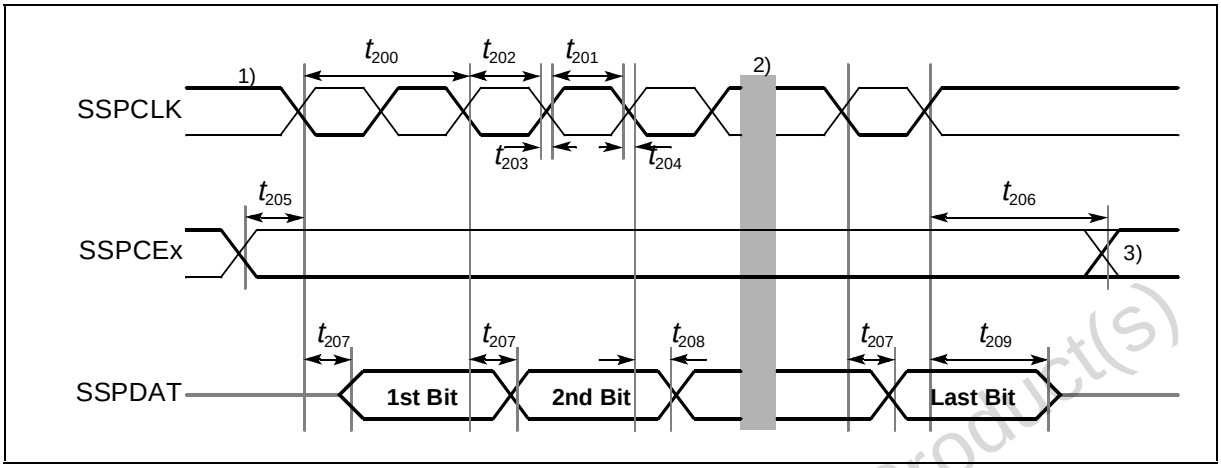


Figure 26 SSP write timing

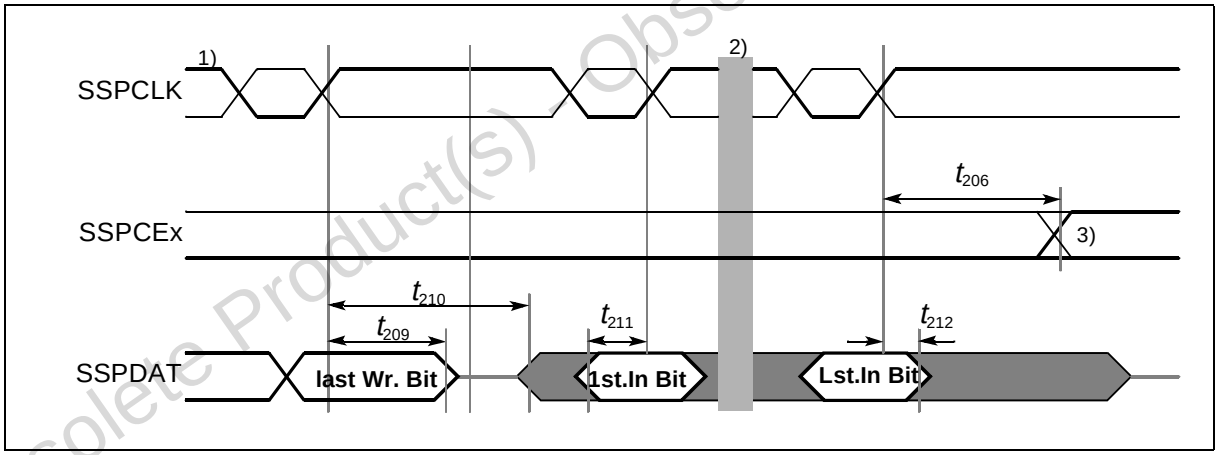


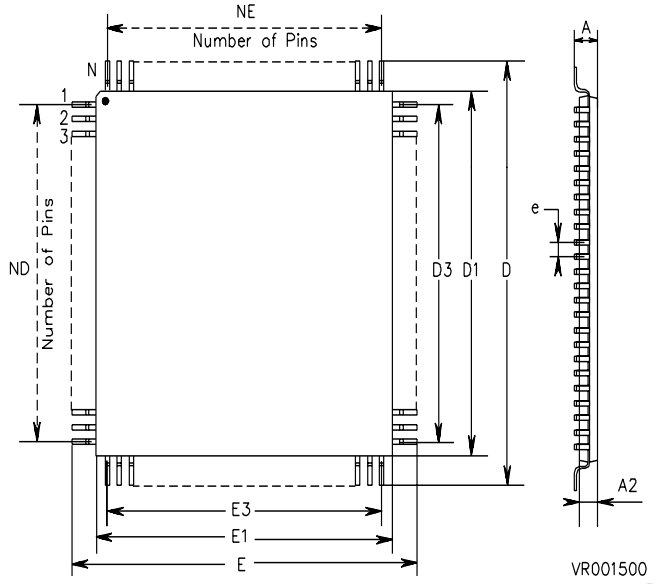
Figure 27 SSP read timing

1 The transition of shift and latch edge of SSPCLK is programmable. This figure uses the falling edge as shift edge (drawn bold).

2 The bit timing is repeated for all bits to be transmitted or received.

3 The active level of the chip enable lines is programmable. This figure uses an active low CE (drawn bold). At the end of a transmission or reception the CE signal is disabled in single transfer mode. In continuous transfer mode it remains active.

16 PACKAGE MECHANICAL DATA



Dim	mm			inches		
	Min	Typ	Max	Min	Typ	Max
A			1.60			0.063
A2	1.35	1.40	1.45	0.053	0.055	0.057
D	15.75	16.00	16.25	0.620	0.630	0.640
D1	13.90	14.00	14.10	0.547	0.551	0.555
D3		12.00			0.472	
E	15.75	16.00	16.25	0.620	0.630	0.640
E1	13.90	14.00	14.10	0.547	0.551	0.555
E3		12.00			0.472	
e		0.50			0.020	
Number of Pins						
ND	25					
NE	25					
N	100					

Figure 28 Package outline TQFP100 (14 x 14 mm)

17 ORDERING INFORMATION

Sales type	Temperature range	Package
ST10R172LT1	0°C to 70°C	TQFP100 (14x 14)
ST10R172LT6	-40°C to +85 °C	